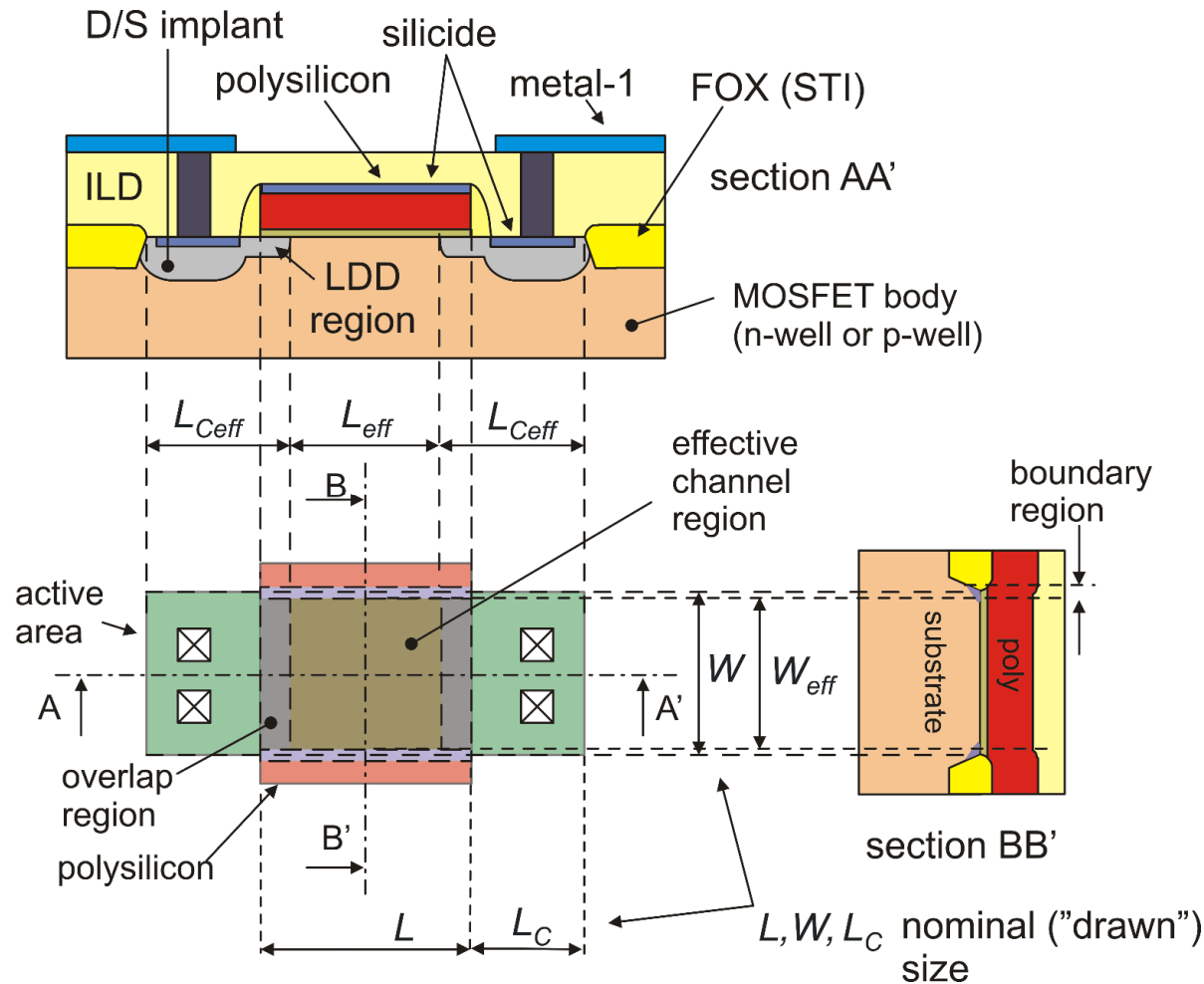


# Planar n-MOSFET cross-section and layout

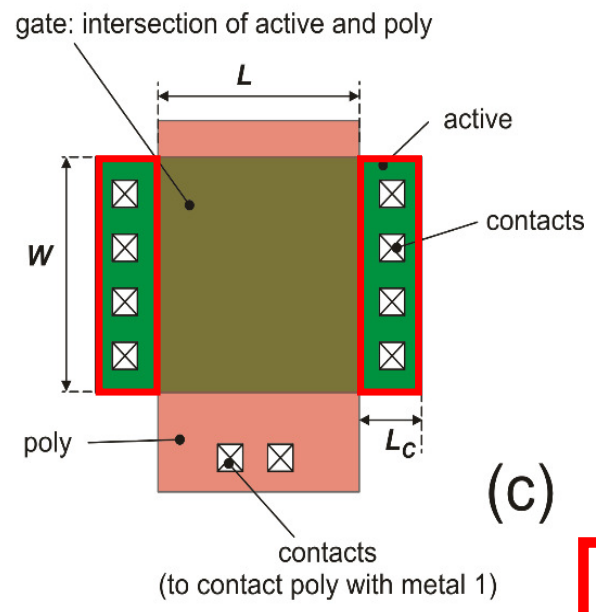
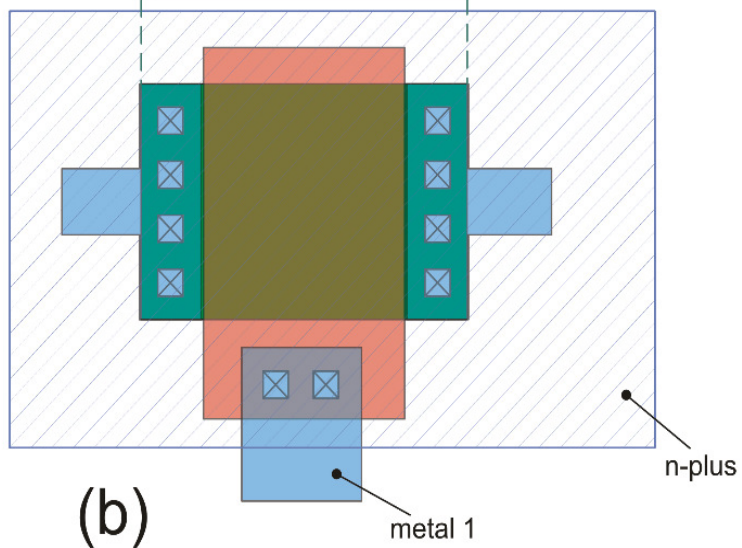
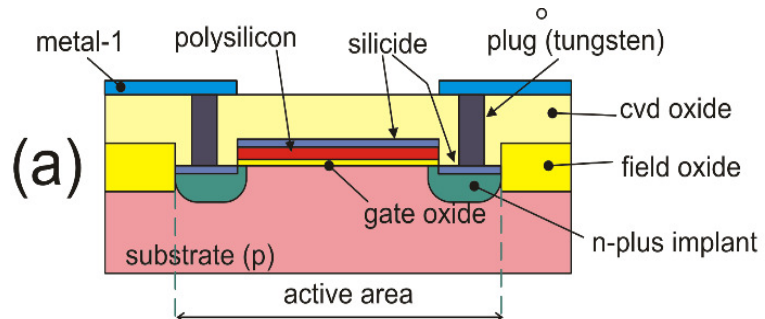


The designer introduces ideal geometrical values ( $L, W ..$ ), while the electrical properties are determined by "effective" values:

$$L_{eff} = L - 2L_D$$

$$W_{eff} = W - 2W_D$$

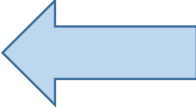
# Simplified layout and cross-section ("designer view")



$$A_D = A_S = WL_C$$

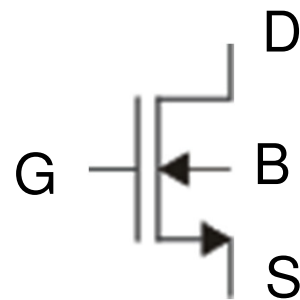
$$P_D = P_S = 2L_C + 2W$$

## MOSFET models

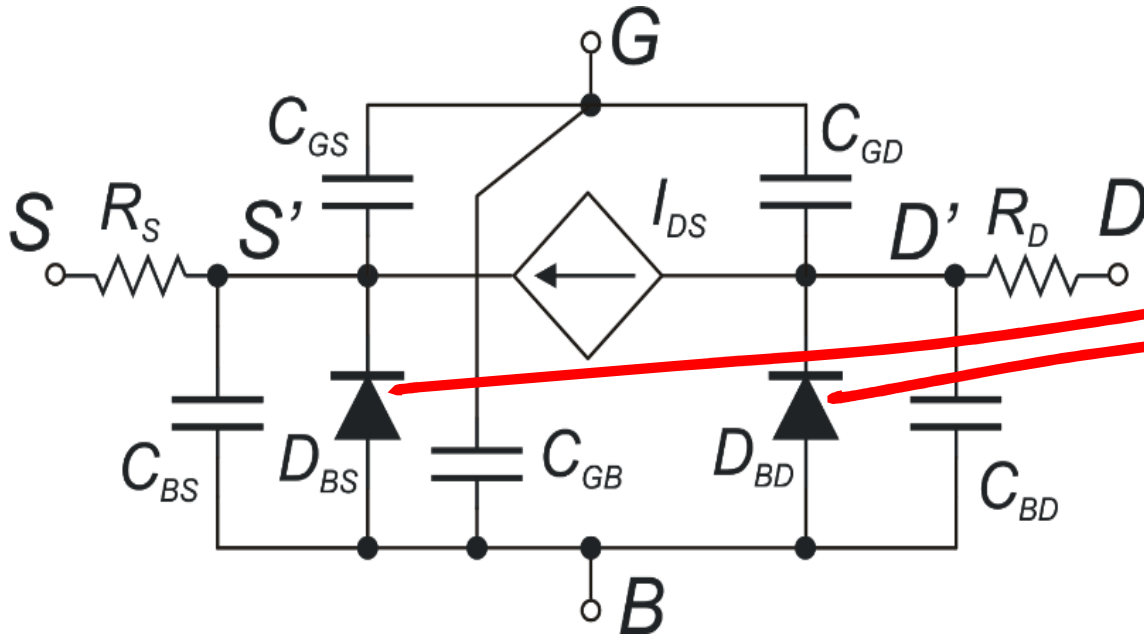
- Models for accurate electrical simulations: BSIM models (Berkeley Short-channel IGFET Model), EKV (Enz, Krummenacher, Vittoz) ...
- Models for "hand calculations": square law (strong inversion)  
exponential laws (weak inversion) 
- It is of primary importance to be able to manually perform first order device sizing and first order performance estimation.
- Only very simple and intuitive model enable the designer to create cells that need only a final refinement and verification in the simulation phase
- The simulator is useless if we do not know how to produce a circuit on scrap-paper. The simulator obeys to the law:  
**garbage in – garbage out**

## MOSFET models: The n-MOSFET

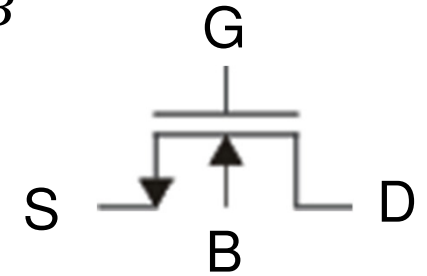
- From this point on, we will consider the behavior of the n-MOSFET, unless otherwise specified. In the end, we will suggest a simple way to transfer all the considerations made for the n-MOSFET to the p-MOSFET
- In integrated circuits, the MOSFET is a four terminal devices: Drain, Source, Gate and Body. In discrete MOSFETs, the body is generally connected to the source internally.



# Large signal MOSFET model (n-MOSFET)



$$V_D, V_S \geq V_B$$

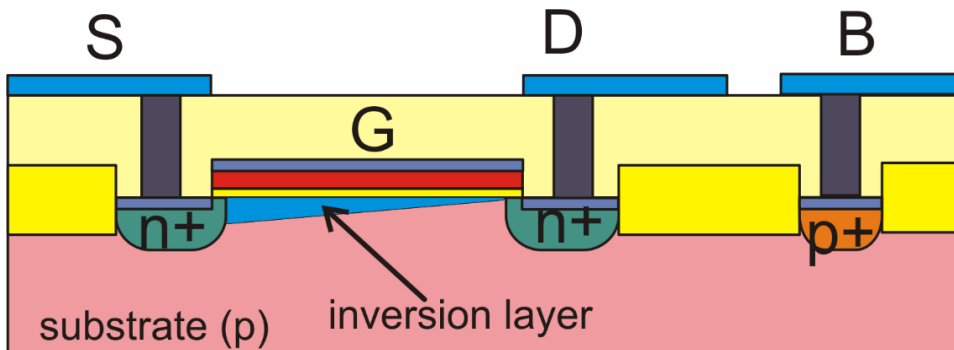


$$I_D \neq I_S \neq I_{DS}$$

In DC, we will always assume:

$$I_D \cong I_S \cong I_{DS}$$

$$R_S = R_D \cong 0$$

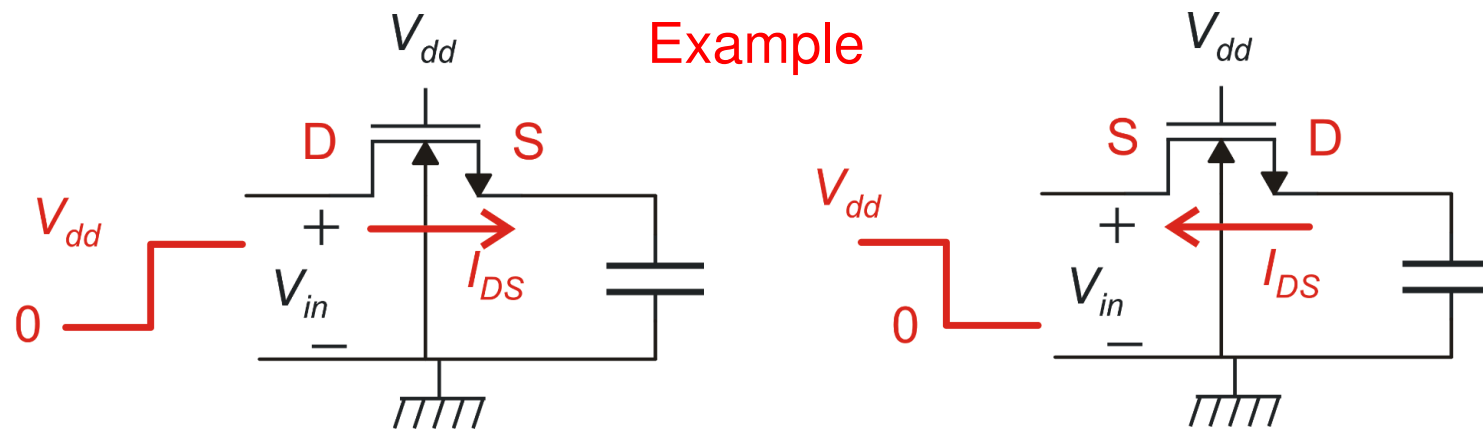


## Source and Drain Symmetry (1)

- The planar MOSFET is symmetric so that drain and source can be swapped with no consequences in the electrical characteristics.
- Equations that use the source as a reference terminal for all relevant voltages can be applied only after finding which terminal is actually playing the role of the source.
- In an **n-MOSFET**, the effective source is the terminal that has the **lower** voltage; the other one of the two, is the actual drain
- In a **p-MOSFET**, the effective source is the terminal that has the **higher** voltage; the other one of the two, is the actual drain

## Source and Drain Symmetry (2)

- With this definition, it is clear that in transient situations, the effective drain and source can swap, depending on the voltage assumed by the terminals.



- In a schematic editor it is necessary to indicate which terminal is the drain and the source. These "conventional" terminals are used to mark all voltages for printing and plotting purposes. This choice does not affect the circuit behavior during the simulations.

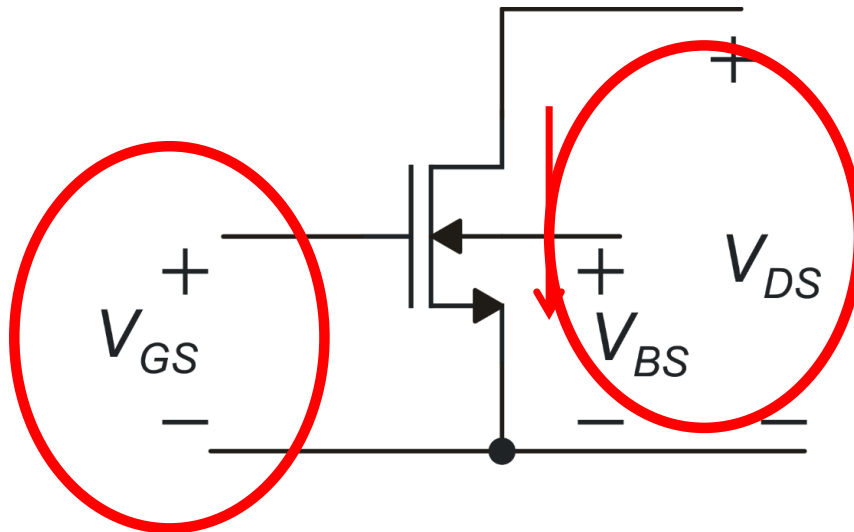
## Source and Drain Symmetry (3)

- If the circuit has a clear static operating point (like most analog circuits), it is convenient to mark as source the terminal that in the operating point is actually working as the source. This will facilitate reading device voltages produced as textual or graphical outputs by the simulator.
- Models like the EKV use the body as the reference for all voltages. In this way drain and sources are perfectly symmetrical also in the equations and there is no need to decide which one is actually working as the source.
- Maintaining the distinction between source and drain is more intuitive and most models oriented to hand calculations are actually based on this choice.



## The $I_{DS}$ model: control voltages

$$I_{DS}(V_{GS}, V_{BS}, V_{DS})$$



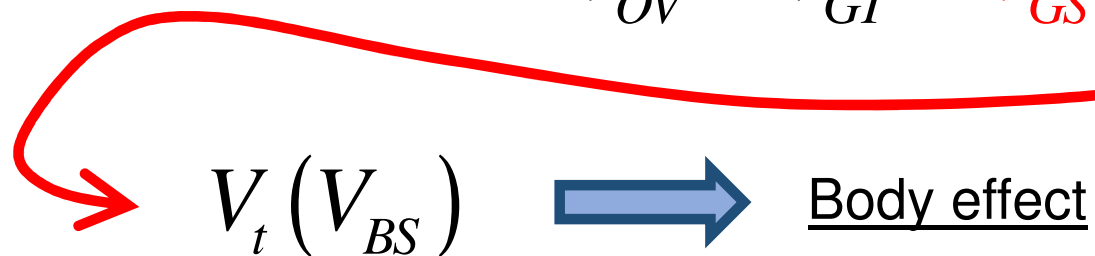
secondary effects:  
generally they are **unwanted**

primary effect  
it is the **wanted** current control

## $V_{GS}$ , $V_{BS}$ and "overdrive voltage"

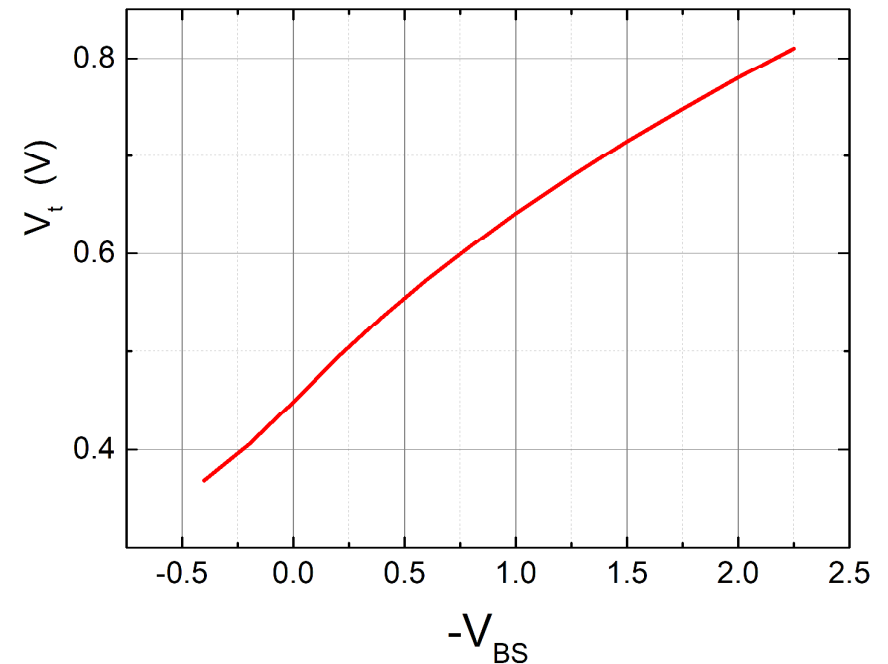
The voltage that really affects the current is the "useful" part of the  $V_{GS}$ , often called "overdrive voltage".

$$V_{OV} = V_{GT} = V_{GS} - V_t$$

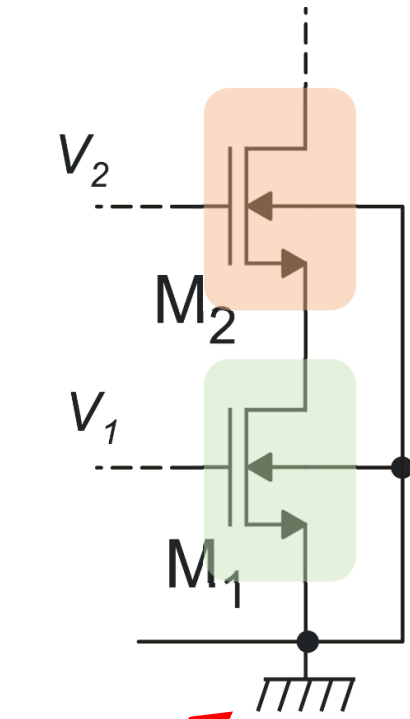


$$V_t = V_{t0} + \gamma \left( \sqrt{\phi_s - V_{BS}} - \sqrt{\phi_s} \right)$$

$$V_{t0} = V_t (V_{BS} = 0) \quad \gamma: \text{body effect coefficient} \quad \phi_s: \text{surface potential}$$



# More on body effect: example



$V_{SS} = gnd$

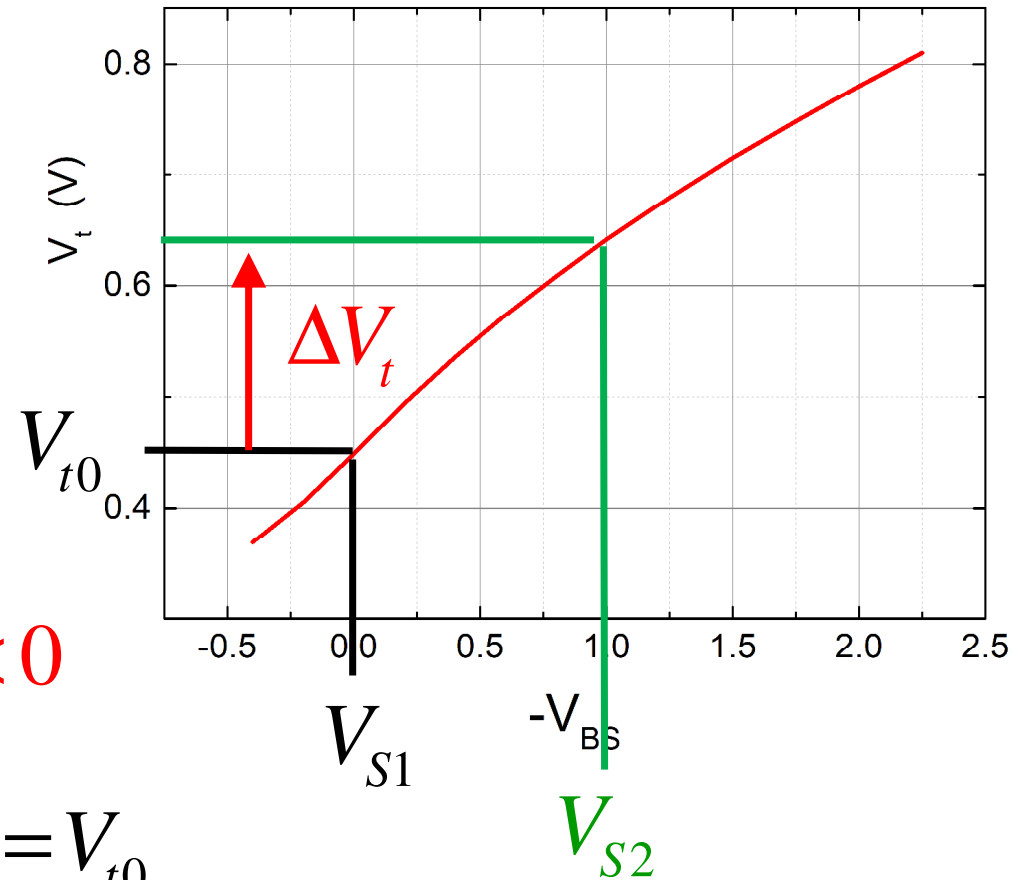
$$V_{B2} = V_{B1} = 0$$

$$V_{S1} = 0$$

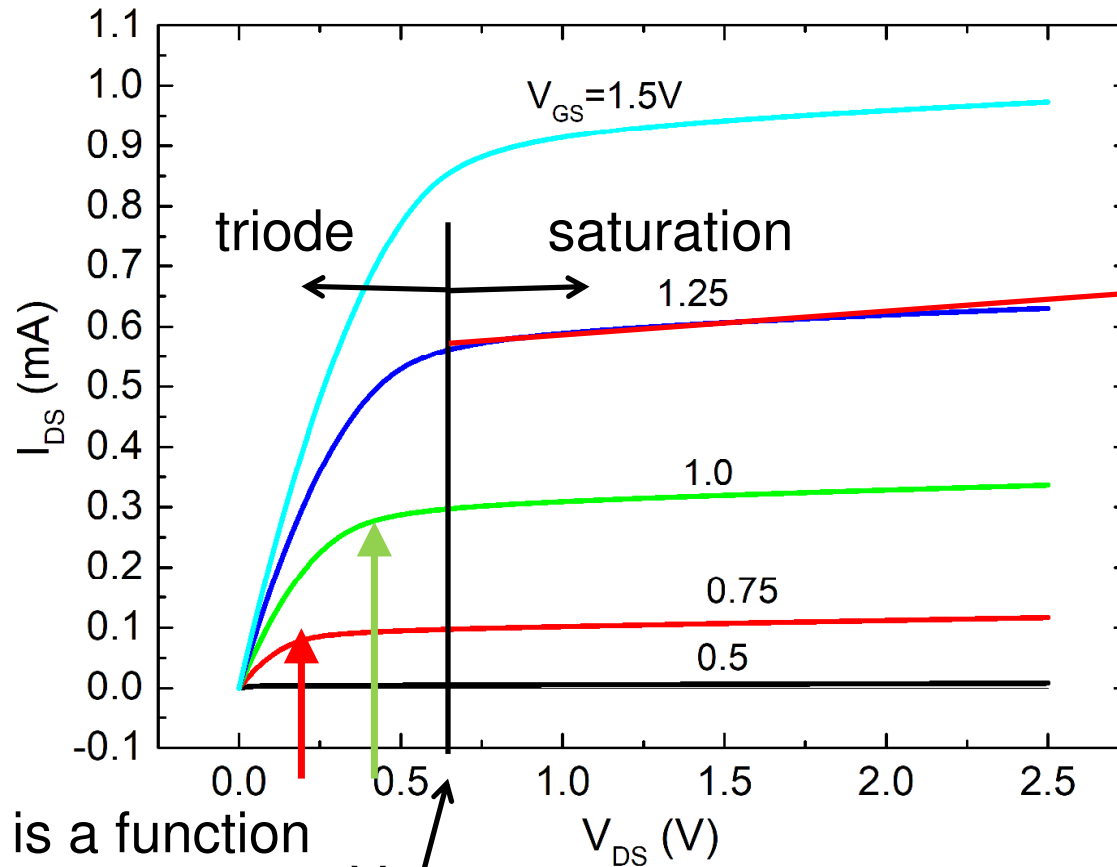
$$V_{S2} = V_{D1} > 0$$

$$V_{BS2} = V_{B2} - V_{S2} < 0$$

$$\begin{cases} V_{BS1} = 0 \Rightarrow V_{t1} = V_{t0} \\ -V_{BS2} = V_{S2} - V_{B2} = V_{DS1} > 0 \Rightarrow V_{t2} = V_{t0} + \Delta V_t \end{cases}$$



# $I_{DS}$ : operating zones on the basis of $V_{DS}$



Triode:  $I_{DS}$  is strongly dependent on  $V_{DS}$

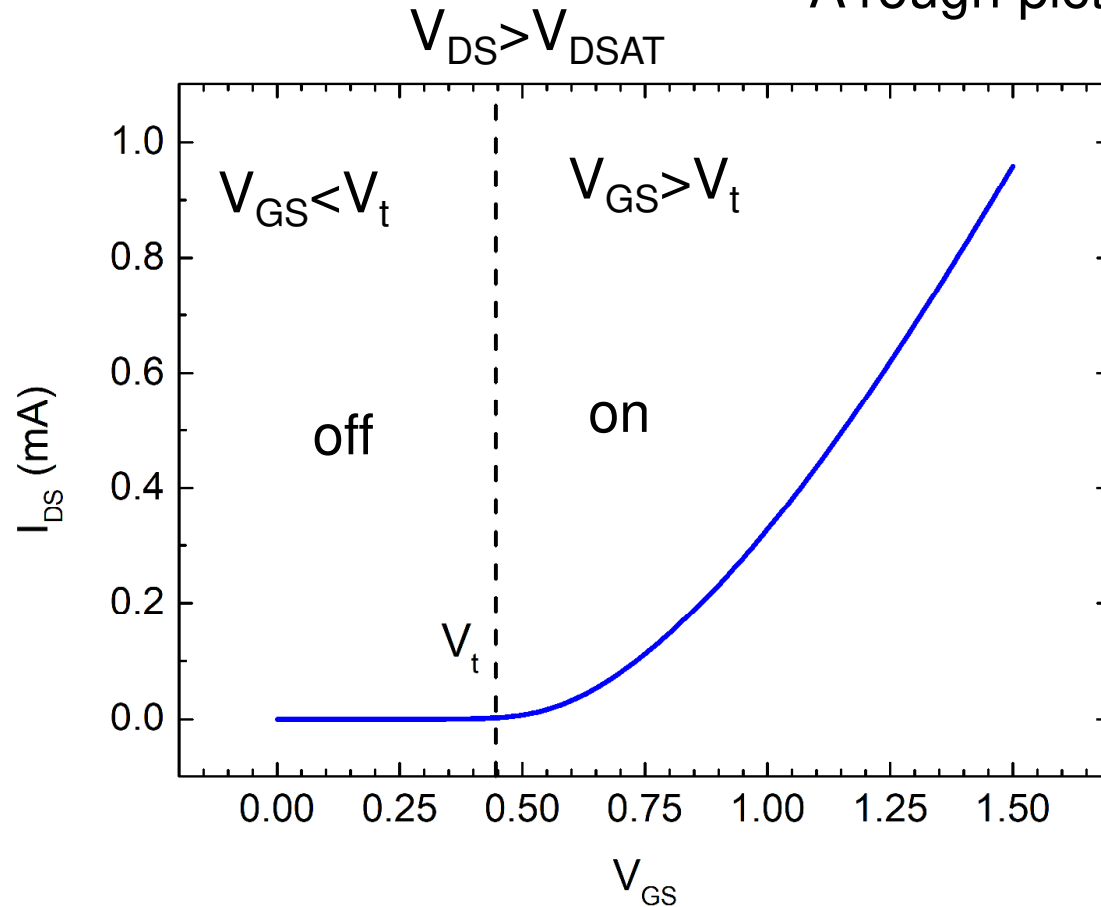
Saturation:  $I_{DS}$  shows a weak and almost linear dependence on  $V_{DS}$

$V_{DSAT}$  is a function of  $V_{GS} - V_t$

$V_{DSAT}$

# Operating zones on the basis of $V_{GS} - V_t$

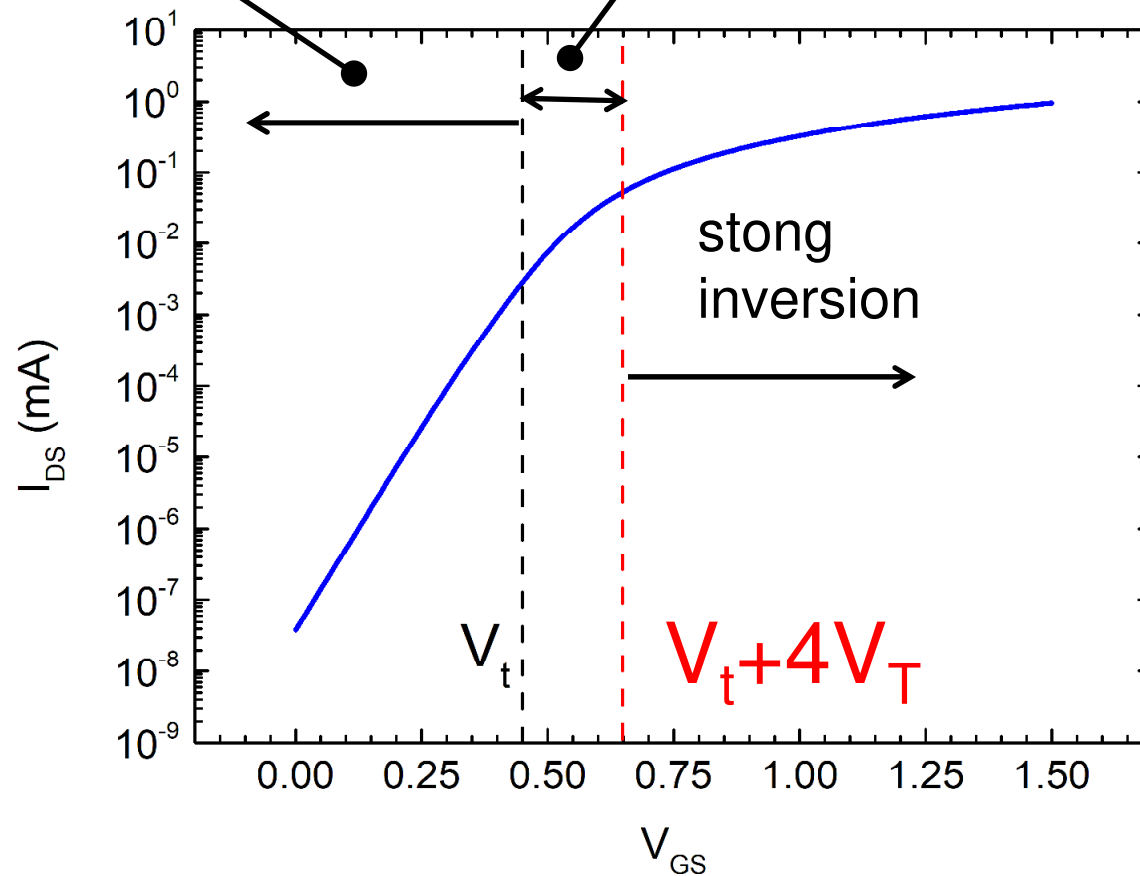
A rough picture:



A more gradual picture: same characteristic with logarithmic y-axis

weak inversion  
(sub-threshold)

moderate inversion



$$V_T = kT/q$$

## $I_{DS}$ : operating zones

	$V_{GS} - V_t \leq 0$	$0 \leq V_{GS} - V_t \leq 4V_T$	$V_{GS} - V_t \geq 4V_T$
$V_{DS} \leq V_{DSAT}$	Triode – Weak Inversion	Triode – Moderate Inversion	Triode – Strong Inversion
$V_{DS} \geq V_{DSAT}$	Saturation – Weak Inversion	Saturation – Moderate Inversion	Saturation – Strong Inversion

$$V_{DSAT} \cong \begin{cases} (V_{GS} - V_t) & \text{in strong inversion} \\ 4V_T \text{ (100 mV)} & \text{in moderate and weak inversion} \end{cases}$$


## $V_{GS} - V_t > 4V_T$ Strong inversion: $I_{DS}$ equations

$$V_{DS} \leq V_{DSAT} \text{ (Triode)} \quad I_{DS} = \beta_n \left( V_{GS} - V_t - \frac{V_{DS}}{2} \right) V_{DS}$$

$$V_{DS} \geq V_{DSAT} \text{ (Saturation)} \quad I_{DS} = \beta_n \frac{(V_{GS} - V_t)^2}{2} \left[ 1 + \lambda (V_{DS} - V_{DSAT}) \right]$$

$$\beta_n = \mu_n C_{OX} \frac{W_{eff}}{L_{eff}} \quad V_{DSAT} = V_{GS} - V_t$$

$$\lambda^{-1} = k_\lambda L_{eff}$$



In some textbooks this term is omitted ( $V_{DSAT}$ ) for simplicity, but this cause a discontinuity between the triode and saturation region



## $I_{DS}$ simplified model in weak inversion

$$I_{DS} = I_{SM} e^{\frac{V_{GS} - V_t}{mV_T}} \left( 1 - e^{\frac{-V_{DS}}{V_T}} \right) \left[ 1 + \lambda (V_{DS} - V_{DSAT}) \right]$$

$m$ : subthreshold slope factor

$$I_{SM} = \mu_n C_{dm} \frac{W_{eff}}{L_{eff}} V_T^2 = \mu_n C_{ox} (m-1) V_T^2 \frac{W_{eff}}{L_{eff}}$$

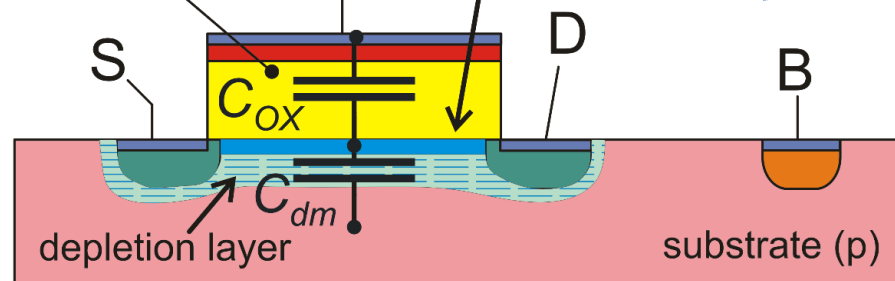
$$m = 1 + \frac{C_{dm}}{C_{ox}}$$

$\beta_n$

gate oxide  
(not to scale)

inversion layer

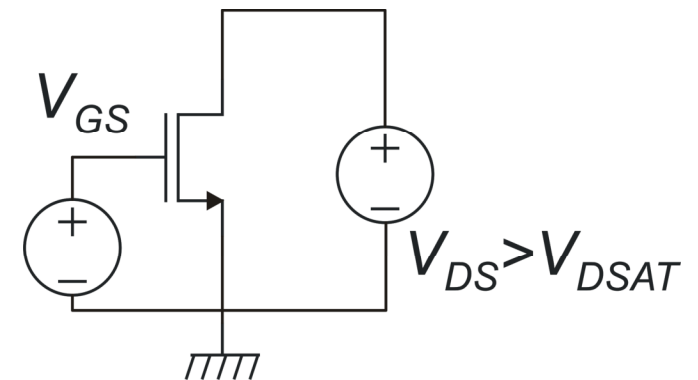
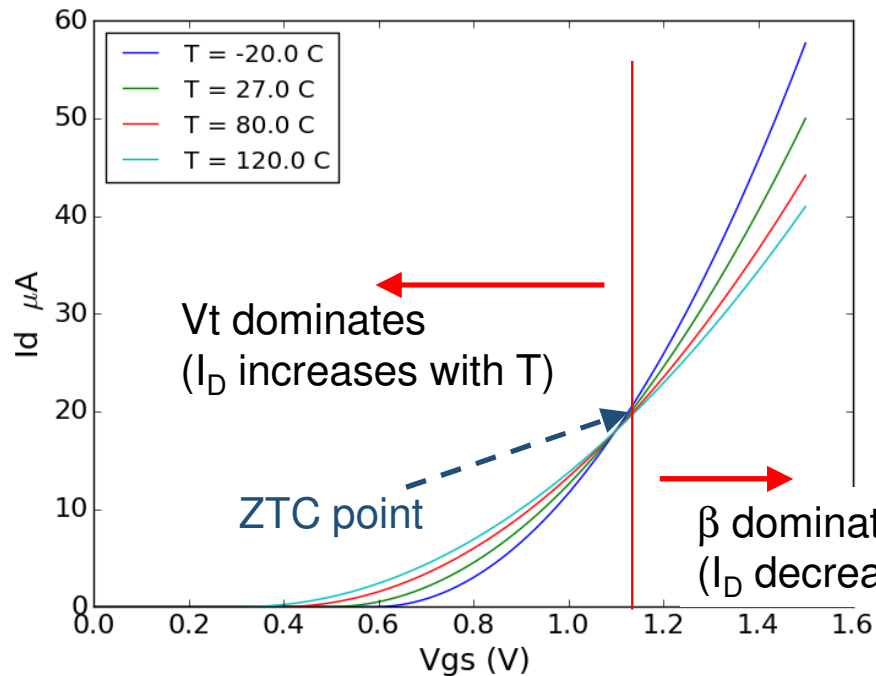
$m \approx 1.2 - 1.3$



## Temperature effects on MOSFET characteristics

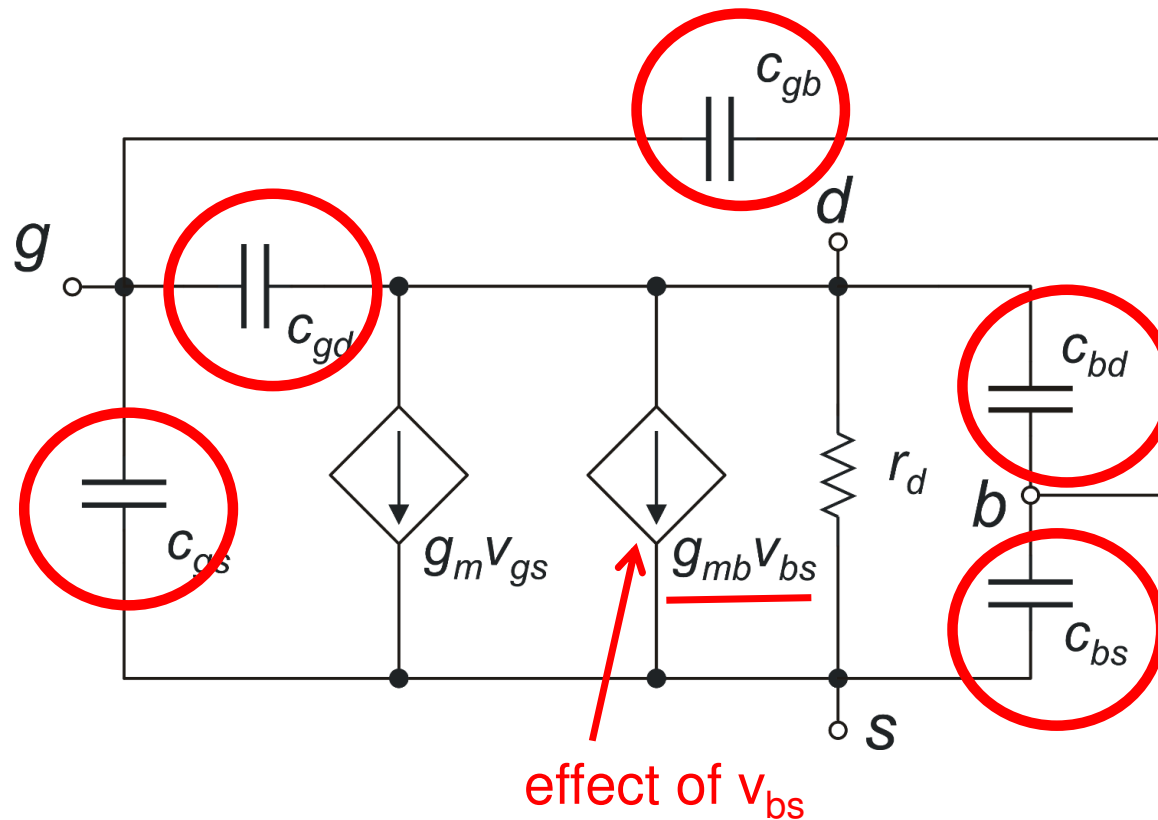
$$\beta_n(T) = \beta_n(T_0) \left( \frac{T}{T_0} \right)^{-\alpha_\mu} \quad \alpha_\mu = 1.2 - 2.4 \text{ (typical 1.5)}$$

$$V_t(T) = V_t(T_0) - \alpha_{VT} (T - T_0) \quad 1 \text{ mV/K} \leq \alpha_{VT} \leq 4 \text{ mV/K}$$

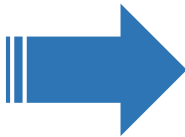


# MOSFET Small Signal model

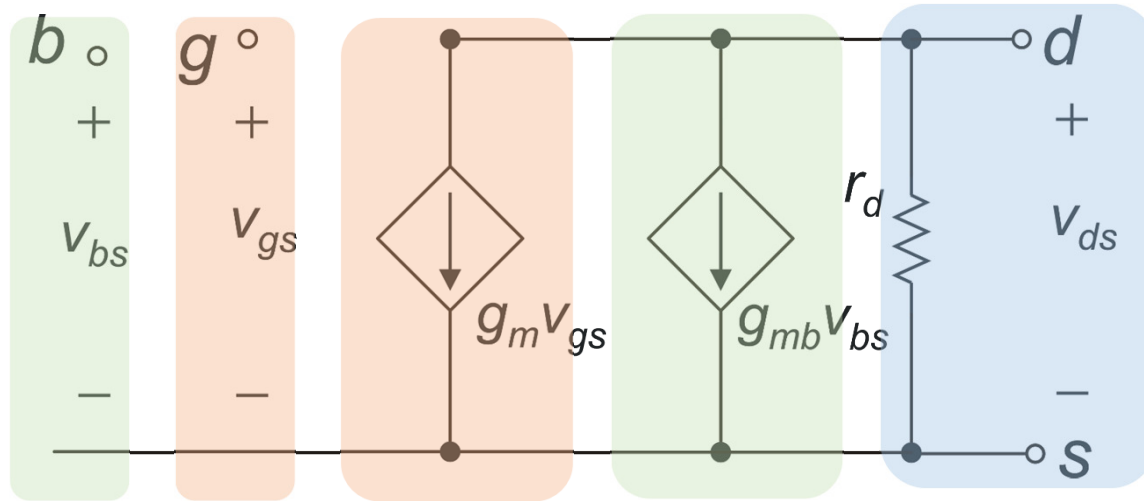
$C_{gs}$ ,  $C_{gd}$ ,  $C_{gb}$ ,  $C_{bd}$ ,  $C_{bs}$  : *small signal capacitances*



Let's start from  
the dc model  
(capacitances are  
removed)



## MOSFET small signal model: dc limit



$$I_D(V_{GS}, V_{BS}, V_{DS})$$



small signal

$$i_d = g_m v_{gs} + g_{mb} v_{bs} + g_d v_{ds}$$

$$g_m = \left. \frac{i_d}{v_{gs}} \right|_{v_{ds}, v_{bs}=0} = \left( \frac{\partial I_D}{\partial V_{GS}} \right)_{V_{DS}, V_{BS}}$$

$$g_{mb} = \left. \frac{i_d}{v_{bs}} \right|_{v_{ds}, v_{gs}=0} = \left( \frac{\partial I_D}{\partial V_{BS}} \right)_{V_{DS}, V_{GS}}$$

$$\frac{1}{r_d} = g_d = \left. \frac{i_d}{v_{ds}} \right|_{v_{gs}, v_{bs}=0} = \left( \frac{\partial I_D}{\partial V_{DS}} \right)_{V_{GS}, V_{BS}}$$

## Body transconductance: $g_{mb}$

$$g_{mb} = \left( \frac{\partial I_D}{\partial V_{BS}} \right)_{V_{DS}=const; V_{GS}=const} \quad I_D(V_{GS}, V_{BS}, V_{DS}) \cong I_D \left[ (V_{GS} - V_t), V_{DS} \right]$$

effect of  $V_{BS}$

let's recall the gm definition

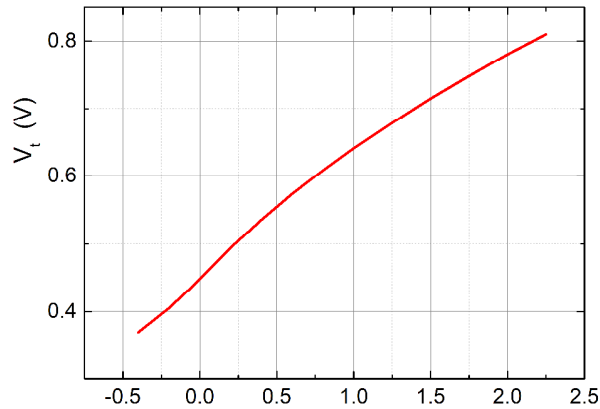
1

$$g_m = \left( \frac{\partial I_D}{\partial V_{GS}} \right)_{V_{DS}, V_{BS}} = \left( \frac{\partial I_D}{\partial (V_{GS} - V_t)} \right)_{V_{DS}} \left( \frac{\partial (V_{GS} - V_t)}{\partial V_{GS}} \right)_{V_{BS}} = \left( \frac{\partial I_D}{\partial (V_{GS} - V_t)} \right)_{V_{DS}} \quad g_m$$

$$g_{mb} = \left( \frac{\partial I_D}{\partial V_{BS}} \right)_{V_{GS}, V_{DS}} = \left( \frac{\partial I_D}{\partial (V_{GS} - V_t)} \right)_{V_{DS}} \left( \frac{\partial (V_{GS} - V_t)}{\partial V_{BS}} \right)_{V_{GS}} = g_m \left( -\frac{\partial V_t}{\partial V_{BS}} \right)_{V_{DS}} \quad g_{mb}$$

=====

## Body transconductance: $g_{mb}$

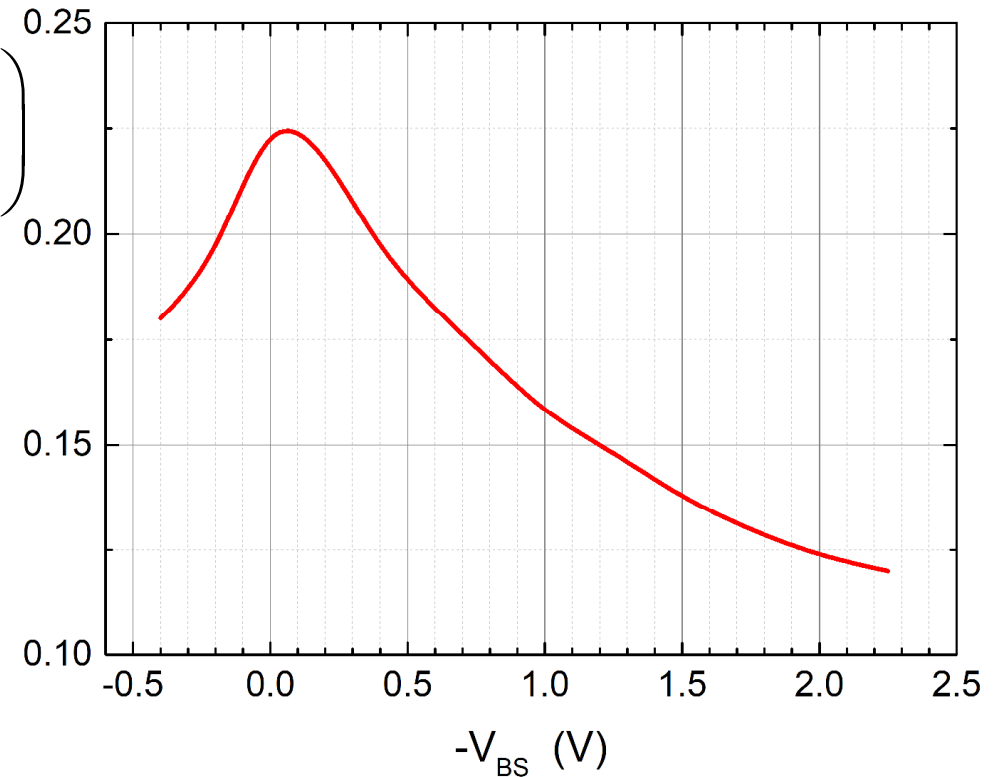


$$\left( -\frac{\partial V_t}{\partial V_{BS}} \right)$$

$$g_{mb} = g_m \left( -\frac{\partial V_t}{\partial V_{BS}} \right) = g_m (m - 1)$$

$$m \sim 1.2 \quad \rightarrow \quad g_{mb} \sim 0.2g_m$$

### Example from simulation



## $g_m$ , $g_d$ in strong inversion

Triode region  $I_{DS} = \beta_n \left( V_{GS} - V_t - \frac{V_{DS}}{2} \right) V_{DS}$

$g_m$   $g_m = \left( \frac{\partial I_D}{\partial V_{GS}} \right)_{V_{DS}, V_{BS}} = \underline{\beta_n V_{DS}}$

$g_d$   $\frac{1}{r_d} = g_d = \left( \frac{\partial I_D}{\partial V_{DS}} \right)_{V_{GS}, V_{BS}} = \beta_n \left[ (V_{GS} - V_t) - \frac{V_{DS}}{2} \right] - \beta_n \frac{V_{DS}}{2} = \underline{\beta_n [(V_{GS} - V_t) - V_{DS}]}$

## $g_m$ , $g_d$ in strong inversion

Saturation region

$$I_{DS} = \beta_n \frac{(V_{GS} - V_t)^2}{2} [1 + \lambda(V_{DS} - V_{DSAT})]$$

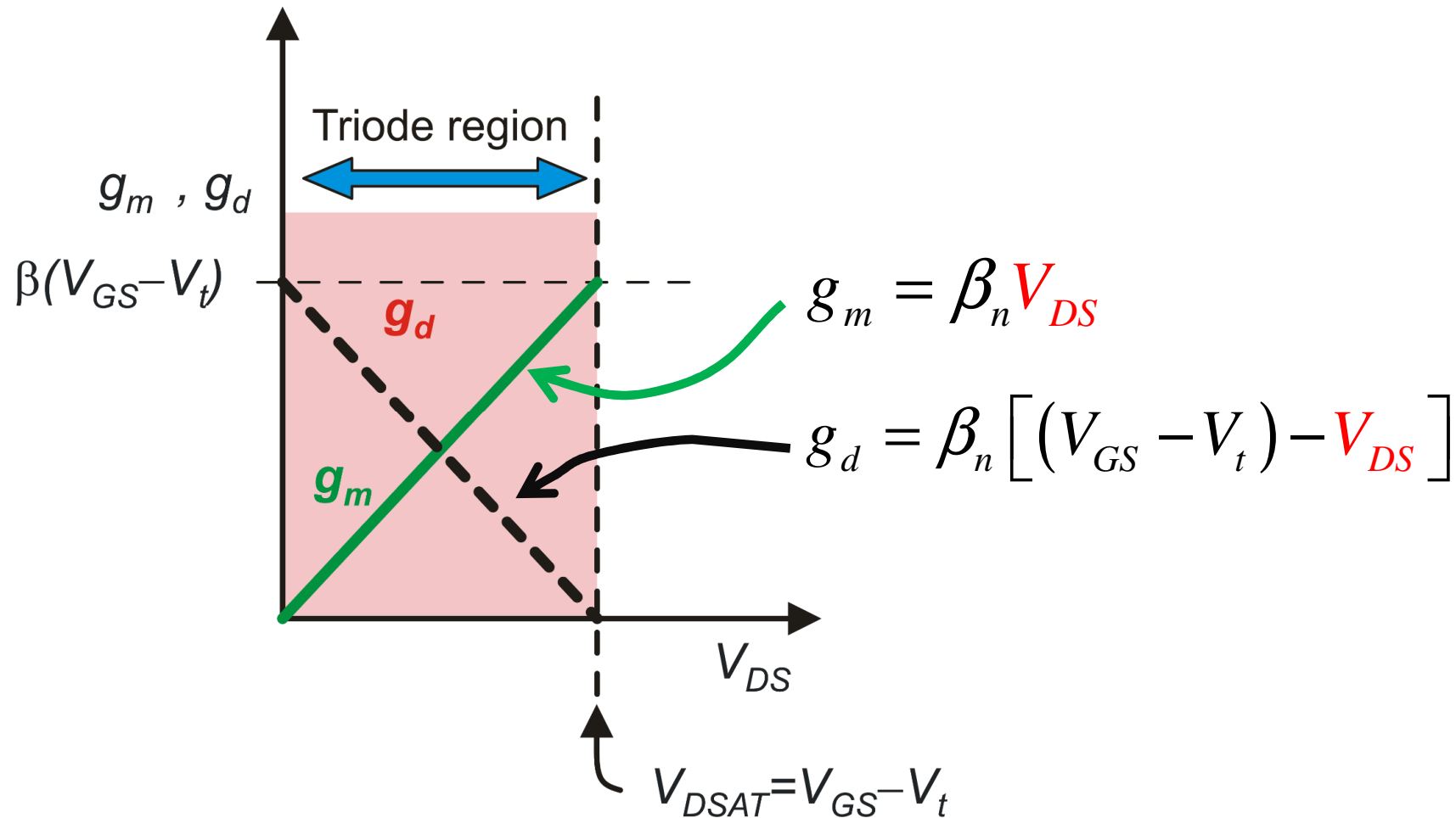
neglecting the dependence of  $V_{DSAT}$  on  $V_{GS}$

$$g_m \equiv \left( \frac{\partial I_{DS}}{\partial V_{GS}} \right)_{V_{DS}, V_{BS}} = \beta_n (V_{GS} - V_t) [1 + \lambda(V_{DS} - V_{DSAT})] \cong \underline{\beta_n (V_{GS} - V_t)}$$

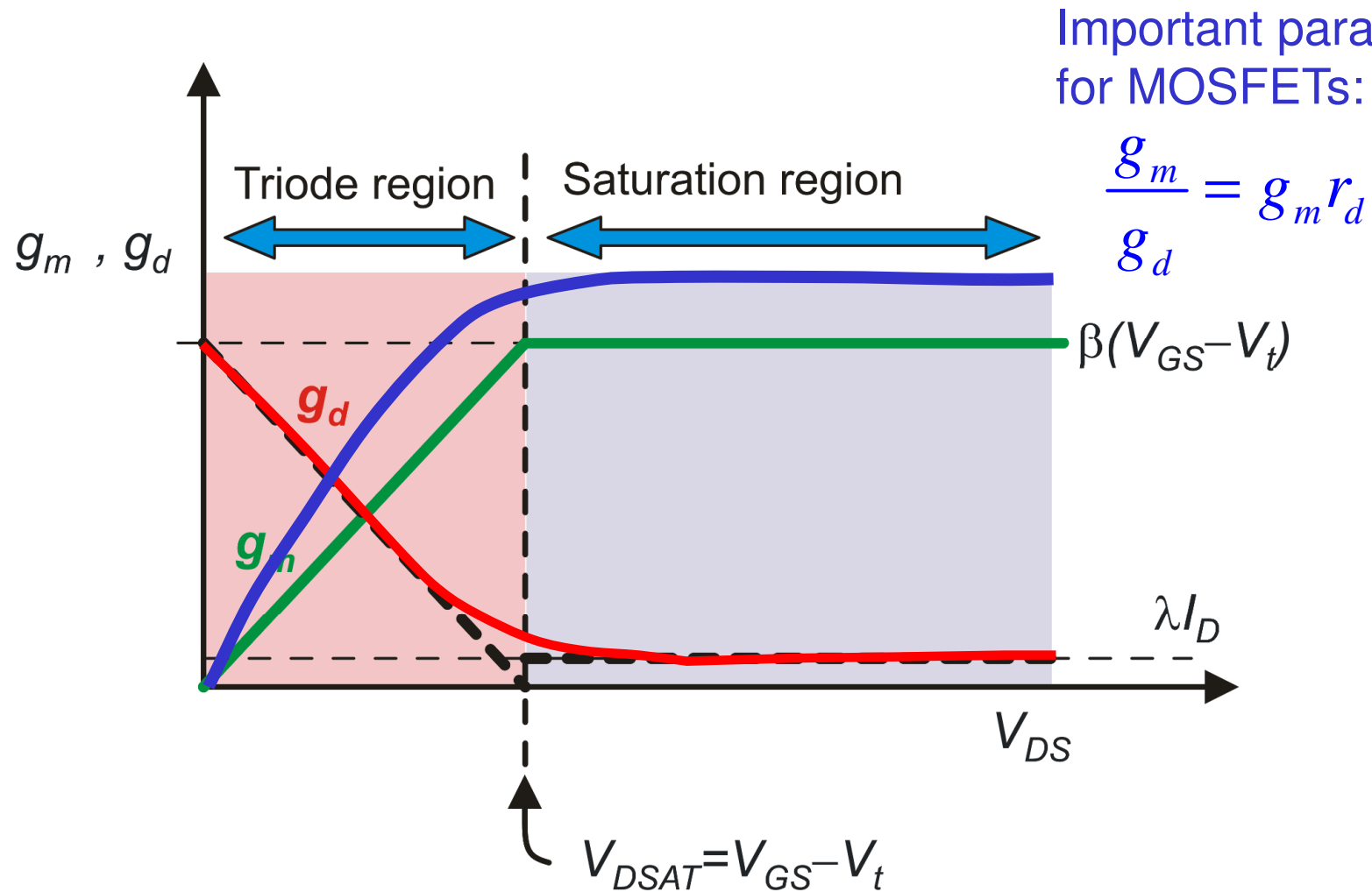
$$\frac{1}{r_d} = g_{ds} \equiv \left( \frac{\partial I_{DS}}{\partial V_{DS}} \right)_{V_{GS}, V_{BS}} = \lambda \frac{\beta_n}{2} (V_{GS} - V_t)^2 \cong \underline{\lambda I_{DS}}$$



## $g_m, g_d$ in strong inversion



# $g_m, g_d$ in strong inversion



## Transconductance models in saturation

**In strong Inversion:**

only a few %

acceptable approximation, because we are studying gm, i.e the effect of  $V_{GS}$

$$I_{DS} = \beta_n \frac{(V_{GS} - V_t)^2}{2} \left[ 1 + \lambda (V_{DS} - V_{DSAT}) \right] \Rightarrow I_{DS} \cong \beta_n \frac{(V_{GS} - V_t)^2}{2}$$

$$(V_{GS} - V_t) = \sqrt{\frac{2I_D}{\beta_n}}$$

$$g_m = \beta_n \sqrt{\frac{2I_D}{\beta_n}} = \sqrt{2I_D \beta_n}$$

$$g_m = \beta_n (V_{GS} - V_t)$$

$$\beta_n = \frac{2I_{DS}}{(V_{GS} - V_t)^2}$$

$$g_m = \frac{2I_{DS}}{(V_{GS} - V_t)} \quad !!!$$

## $g_m, g_d$ in weak inversion

$$I_{DS} = I_{SM} e^{\frac{V_{GS} - V_t}{mV_T}} \left( 1 - e^{\frac{-V_{DS}}{V_T}} \right) \left[ 1 + \lambda (V_{DS} - V_{DSAT}) \right]$$

$$g_m = \left( \frac{\partial I_D}{\partial V_{GS}} \right)_{V_{DS}, V_{BS}} = \frac{1}{mV_T} I_{SM} e^{\frac{V_{GS} - V_t}{mV_T}} \left( 1 - e^{\frac{-V_{DS}}{V_T}} \right) \left[ 1 + \lambda (V_{DS} - V_{DSAT}) \right] = \frac{I_D}{mV_T} \quad \text{Exact result}$$

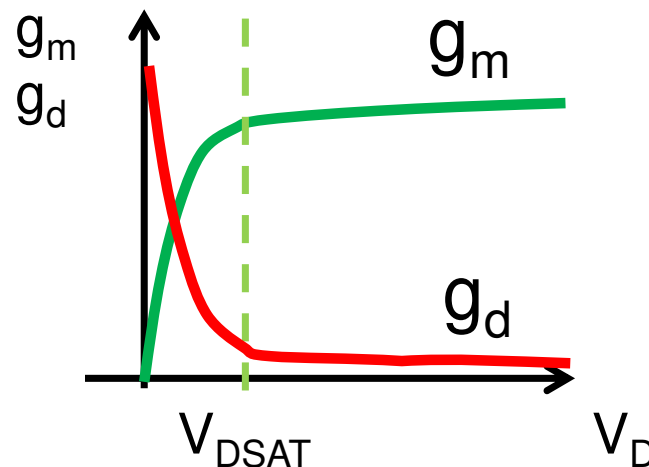
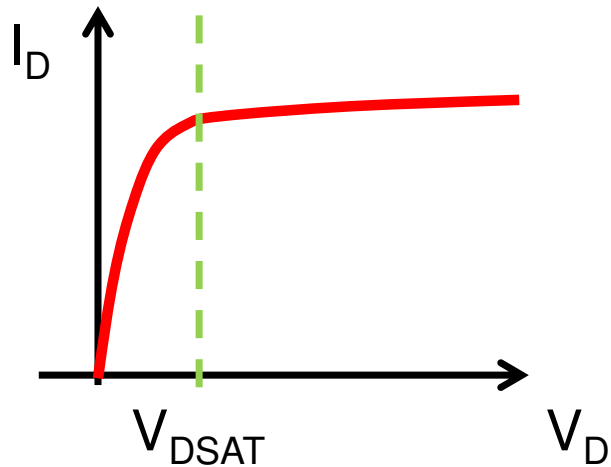
$$\frac{1}{r_d} = g_d = \left( \frac{\partial I_D}{\partial V_{DS}} \right)_{V_{GS}, V_{BS}} =$$

$$= \frac{I_{SM}}{V_T} e^{\frac{V_{GS} - V_t}{mV_T}} e^{\frac{-V_{DS}}{V_T}} \left[ 1 + \lambda (V_{DS} - V_{DSAT}) \right] + \lambda I_{SM} e^{\frac{V_{GS} - V_t}{mV_T}} \left( 1 - e^{\frac{-V_{DS}}{V_T}} \right)$$

## $g_m, g_d$ in weak inversion

$$g_m = \frac{I_D}{mV_T}$$

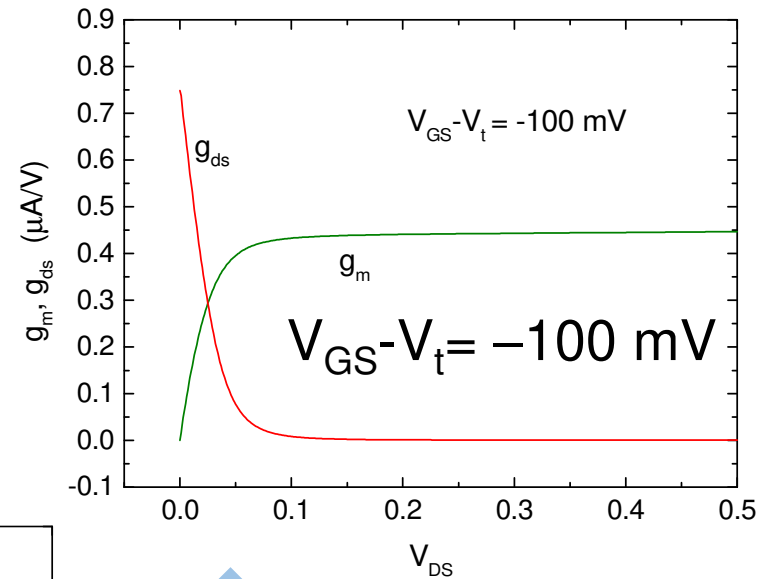
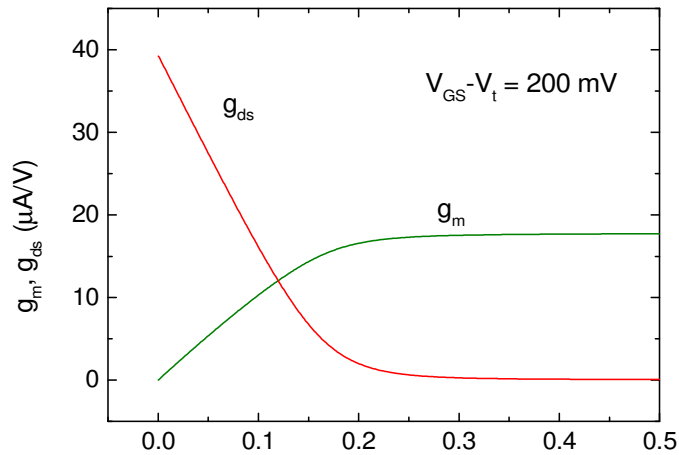
$$g_d = \frac{I_{SM}}{V_T} e^{\frac{V_{GS}-V_t}{mV_T}} e^{\frac{-V_{DS}}{V_T}} \left[ 1 + \lambda(V_{DS} - V_{DSAT}) \right] + \lambda I_{SM} e^{\frac{V_{GS}-V_t}{mV_T}} \left( 1 - e^{\frac{-V_{DS}}{V_T}} \right) \Rightarrow \underline{\underline{g_d \cong \lambda I_D}}$$



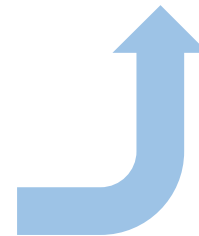
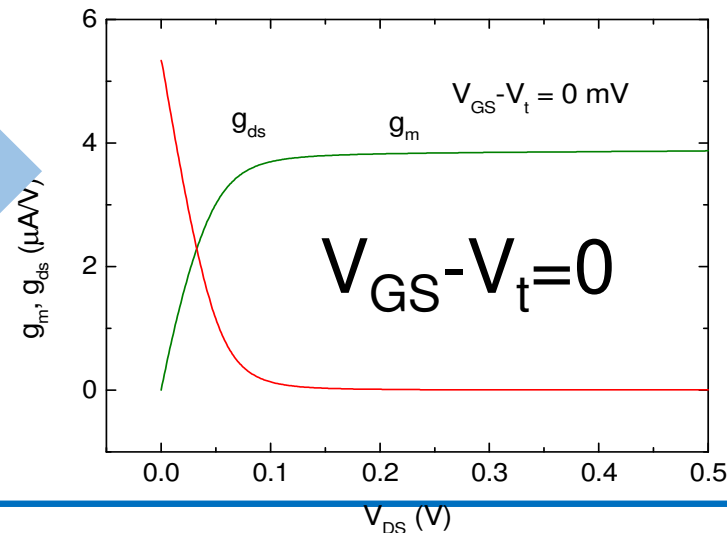
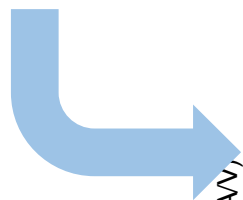
In saturation:  $e^{\frac{-V_{DS}}{V_T}} \rightarrow 0$

# $g_m, g_d$ everywhere: simulations

Strong inversion



$V_{GS}-V_t = 200$  mV



# Unified model for transconductance in saturation

## Strong Inversion

$$g_m = \frac{2I_{DS}}{(V_{GS} - V_t)} = \frac{I_{DS}}{\frac{(V_{GS} - V_t)}{2}}$$

$\frac{g_m}{I_D}$  Important parameter for analog circuit design

## Weak Inversion

$$g_m = \frac{I_D}{mV_T}$$

## BJT

$$g_m = \frac{I_C}{V_T}$$

$$g_m = \frac{I_D}{V_{TE}}$$

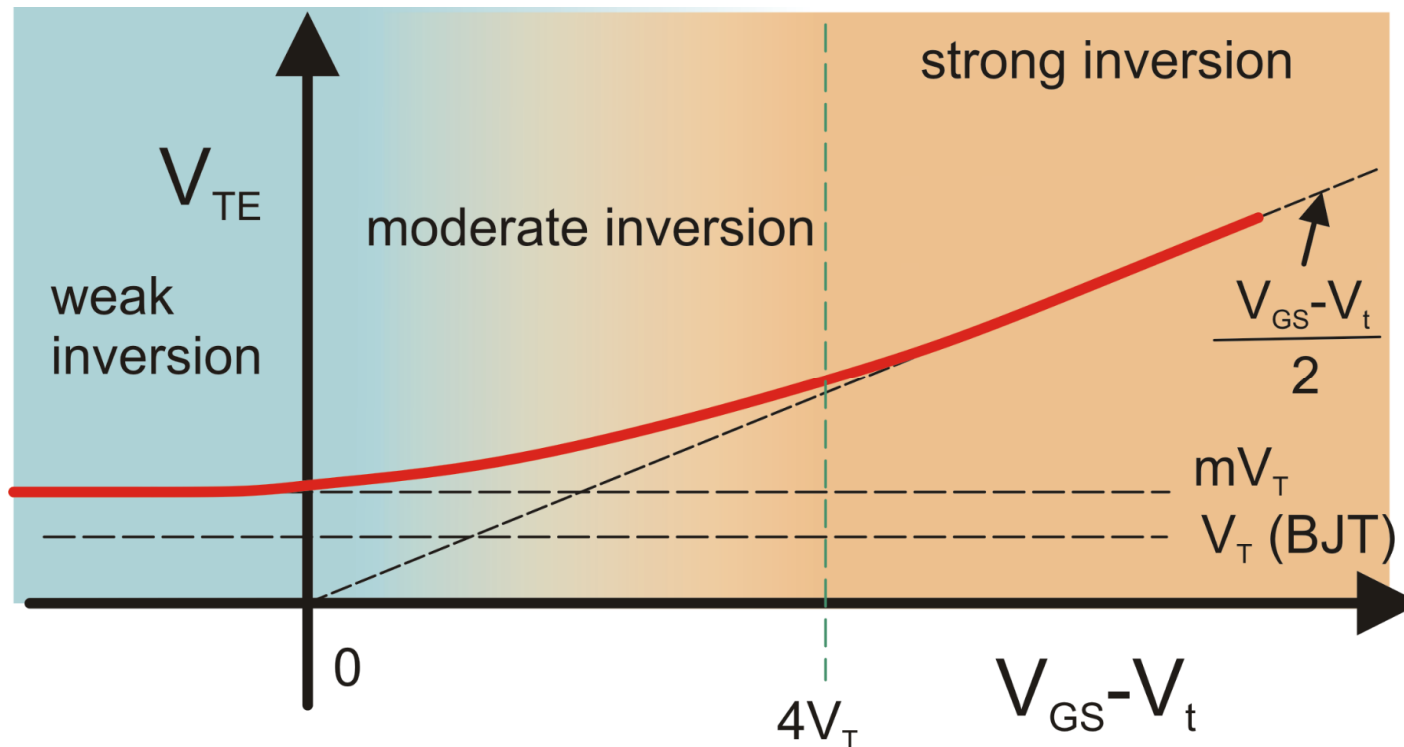
with  $V_{TE} = \left( \frac{g_m}{I_D} \right)^{-1}$

Definition of  $V_{TE}$

$$= \begin{cases} \frac{(V_{GS} - V_t)}{2} & \text{Strong inversion} \\ mV_T & \text{Weak inversion} \\ V_T & \text{BJT} \end{cases}$$

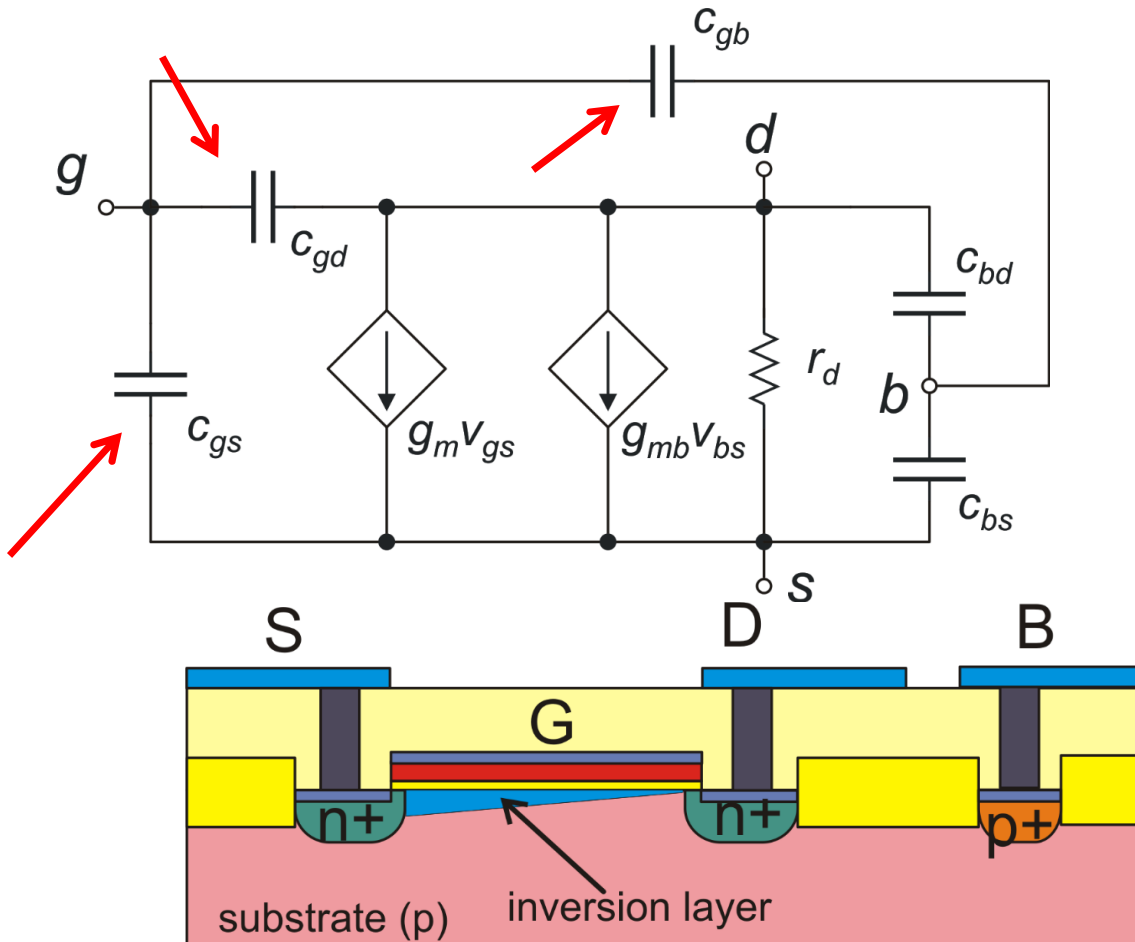
## Effective Thermal Voltage: $V_{TE}$

The smaller the  $V_{TE}$ , the higher the  $g_m$  that can be obtained with a given  $I_D$





# MOSFET Capacitance Model: gate related capacitances



extrinsic cap.

intrinsic cap..

$$C_{gs} = C_{gs}^{(ov)} + C_{gs}^{(i)}$$

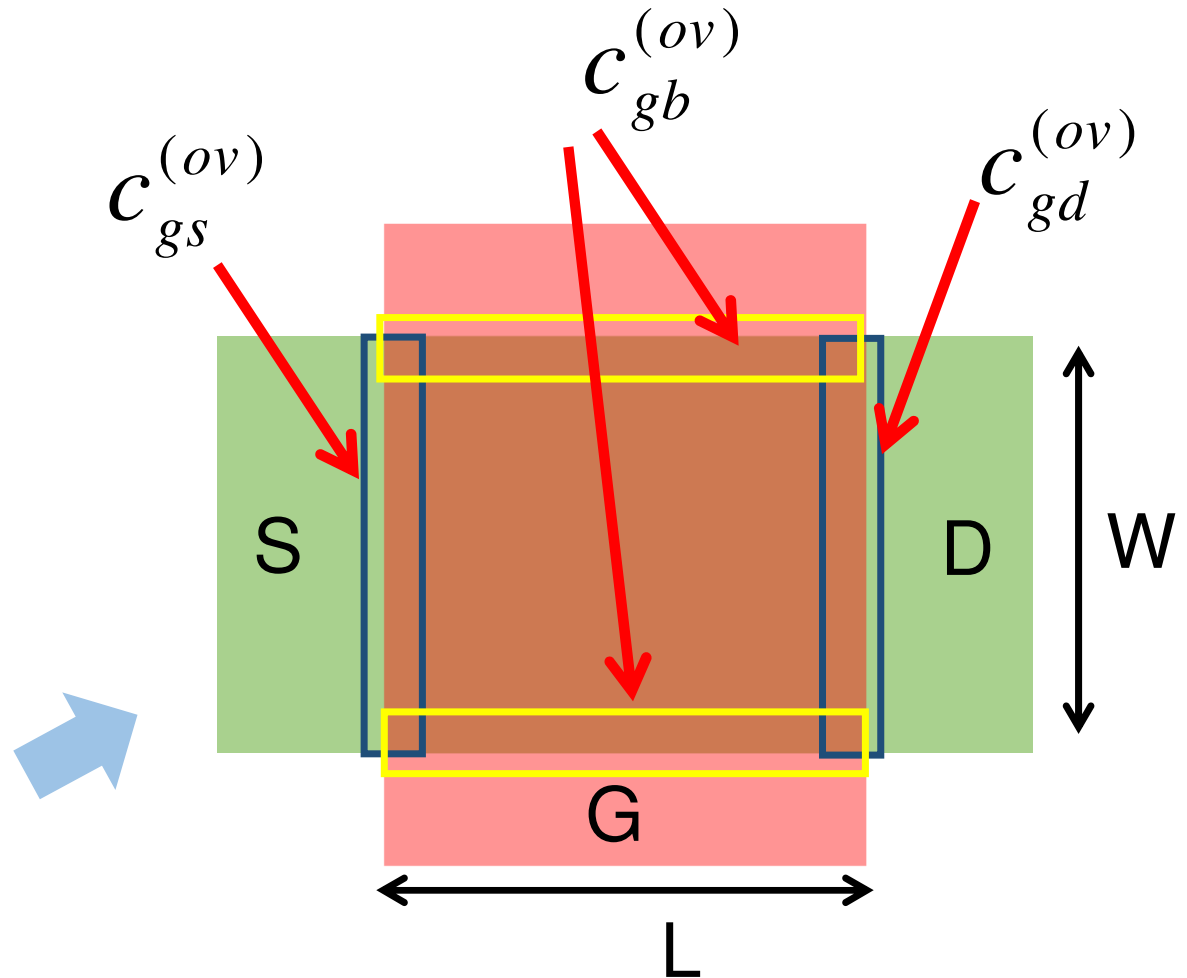
$$C_{gd} = C_{gd}^{(ov)} + C_{gd}^{(i)}$$

$$C_{gb} = C_{gb}^{(ov)} + C_{gb}^{(i)}$$

## Estrinsic Capacitances

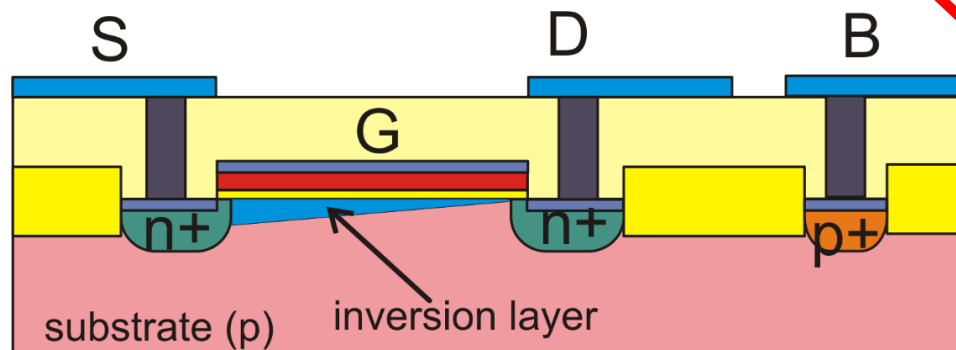
$$\begin{aligned}
 \rightarrow & \left\{ \begin{aligned} C_{gs}^{(ov)} &= C_{gso} \cdot W \\ C_{gd}^{(ov)} &= C_{gdo} \cdot W \end{aligned} \right. \\
 \rightarrow & \\
 \rightarrow & \left\{ \begin{aligned} C_{gb}^{(ov)} &= C_{gbo} \cdot L \end{aligned} \right.
 \end{aligned}$$

Localization of extrinsic capacitances: along the borders of the gate



## Intrinsic capacitances: The Meyer Model

	Off ( $V_{GS} \ll V_t$ )	Triode	Saturation
$C_{gs}^{(i)}$	0	$\frac{1}{2}C_{OX}WL$	$\frac{2}{3}C_{OX}WL$
$C_{gd}^{(i)}$	0	$\frac{1}{2}C_{OX}WL$	0
$C_{gb}^{(i)}$	$\left(\frac{1}{C_{OX}WL} + \frac{1}{C_{dm}}\right)^{-1}$	0	0

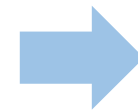


Series of the oxide and depletion layer capacitances. Can be approximated with only the oxide cap  $C_{OX}WL$

## Charge oriented models (Dutton and Ward model)

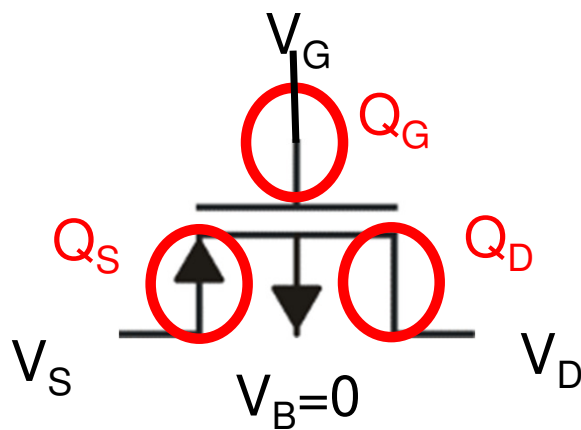
Limits of the Meyer Model:

- Does not guarantee charge conservation
- Capacitances are reciprocal



Important errors in circuits using MOSFETs as switches.

### Dutt and Ward model



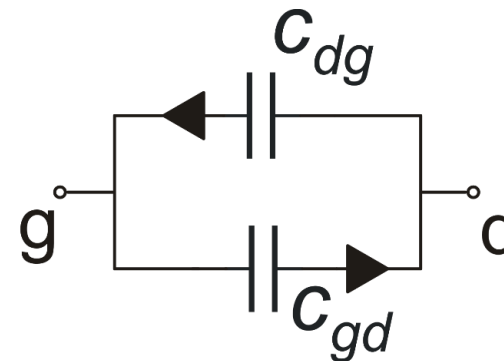
$$C_{ij} = \frac{\partial Q_i}{\partial V_j}$$

Array of 9 capacitances

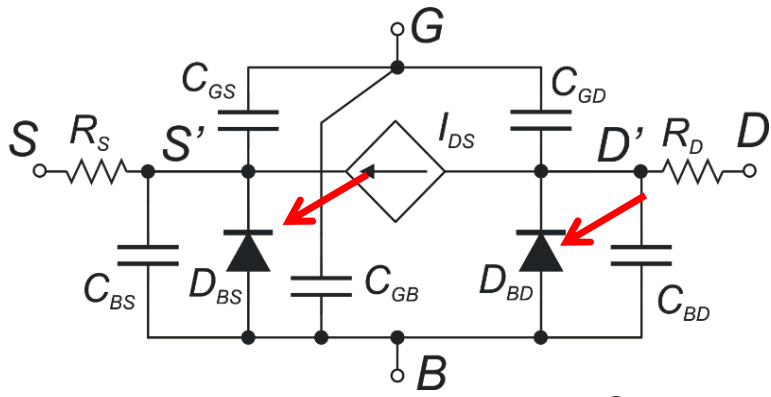
$C_{ij}$  are  $< 0$  for  $i \neq j$  (trans-capacitances)

$C_{ij}$  are  $> 0$  for  $i = j$  (self capacitances)

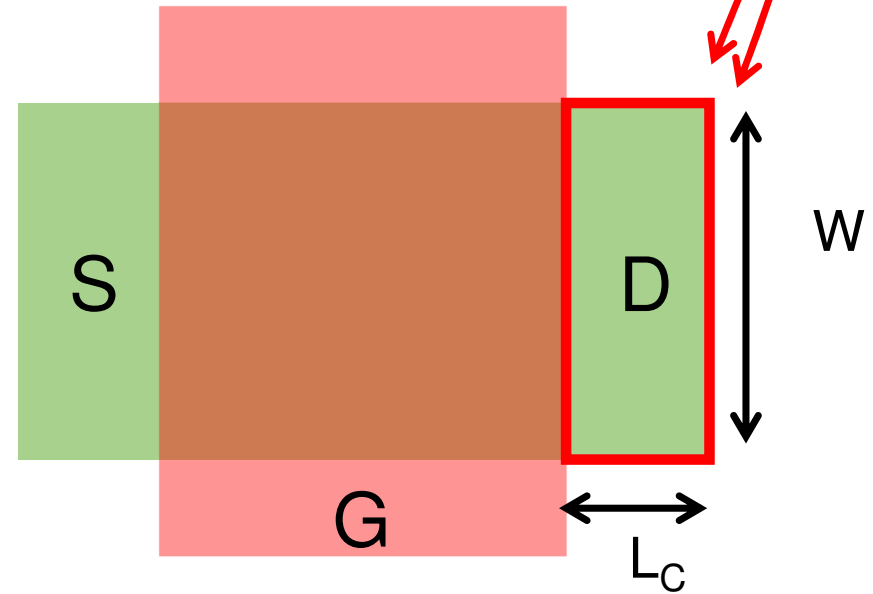
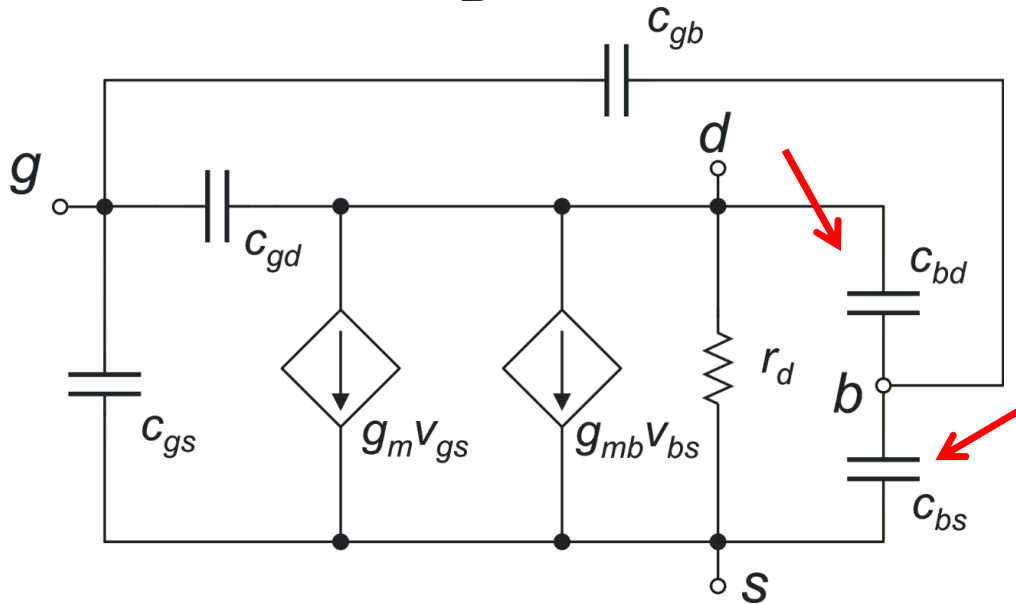
Generally:  $C_{ij} \neq C_{ji}$



# Junction capacitances



$$C_{bd} = \frac{C_J A_D}{\left(1 + \frac{V_{SB}}{V_0}\right)^{m_j}} + \frac{C_{JSW} P_D}{\left(1 + \frac{V_{SB}}{V_0}\right)^{m_{jsw}}}$$



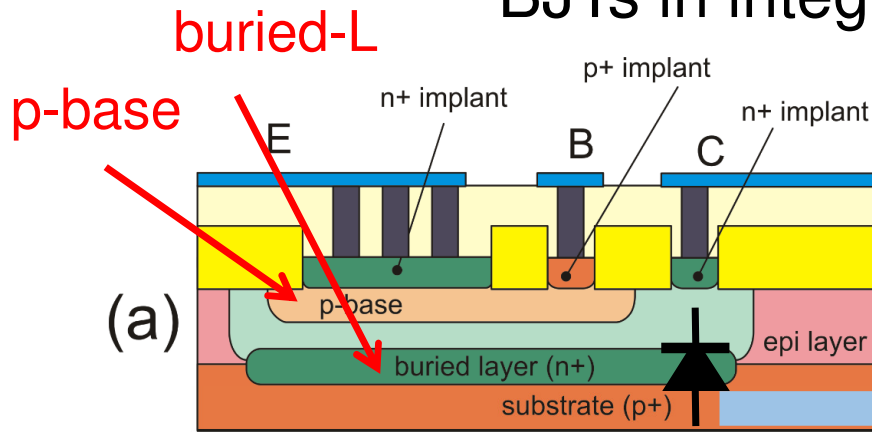
## Other non-idealities of the MOSFET behaviour

Gate-bias dependent mobility →  $\mu C_{ox}$  depends on  $V_{GS}$  (decreases at high  $V_{GS}$ )  
**(all devices)**

Carrier velocity saturation →  $I_D$  dependence on  $V_{GS}$  in strong inversion tends to become linear (instead of quadratic)  
**(Short channel devices)**. Again, appears as a reduction of the  $\mu C_{ox}$  at high  $V_{GS}$

Gate current → May be due to tunneling **(all devices)**  
or hot electrons - hot holes **(Short channel devices)**

# BJTs in integrated circuits: Vertical NPN

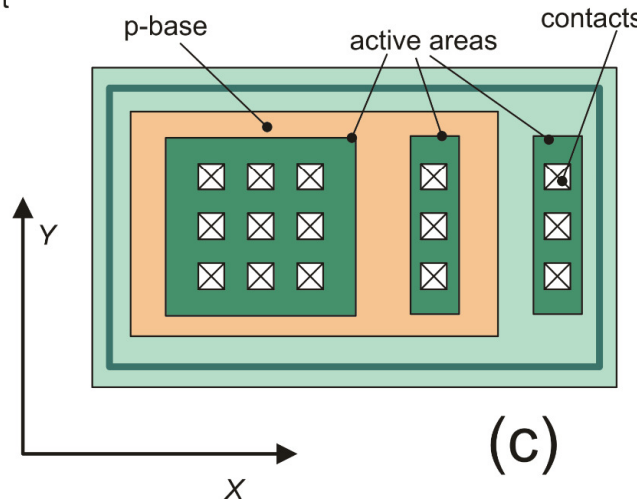
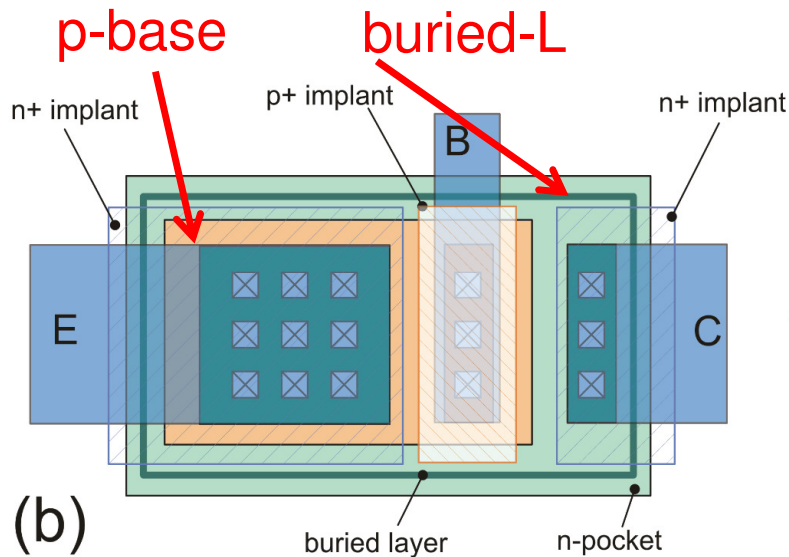


BiCMOS: CMOS + p-base and buried-layer

The **n-pocket** can be an n-well

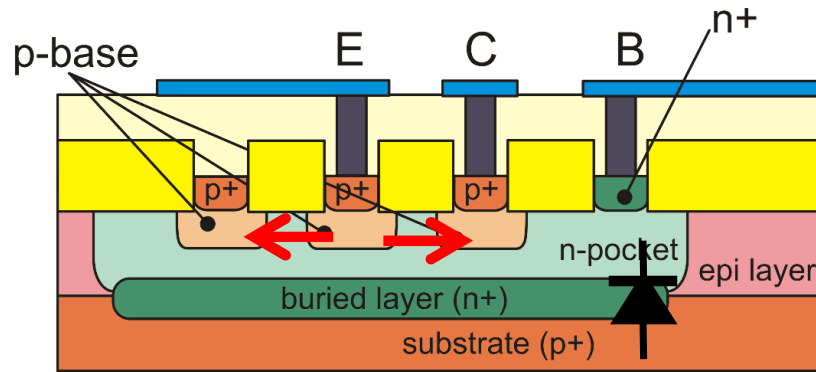
The **buried-layer** a buried-well of a triple-well CMOS

A diode between collector and substrate is present → capacitance

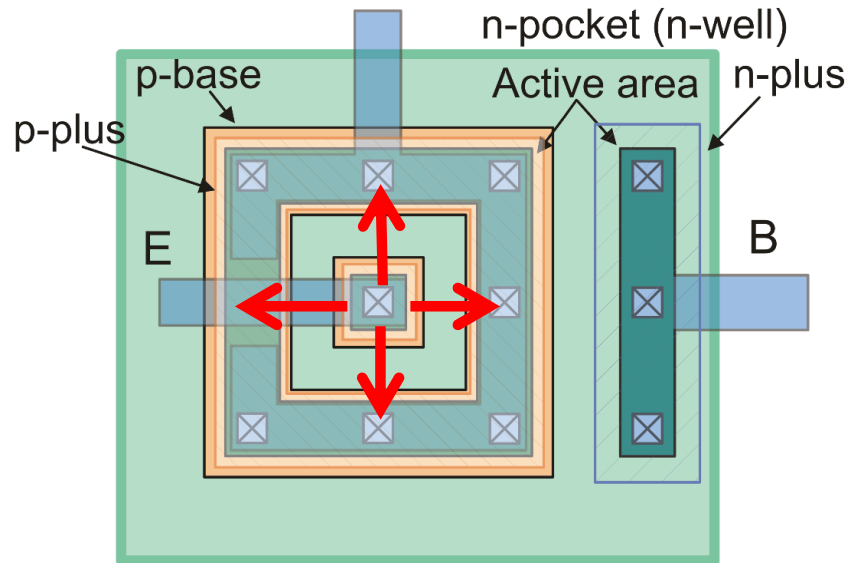


Same as (b) but with the Metal 1 removed

## The lateral PNP



Slower than vertical devices due to large base series resistance ( $r_{bb'}$ ) and base-to-substrate capacitance

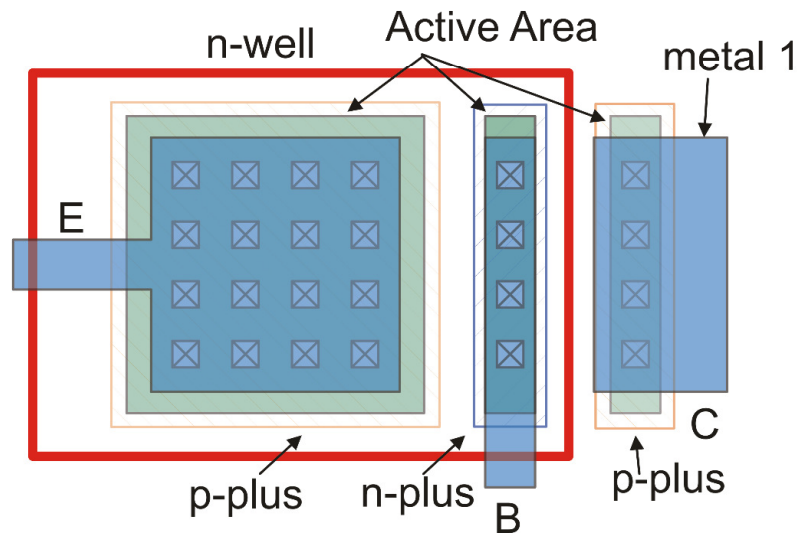
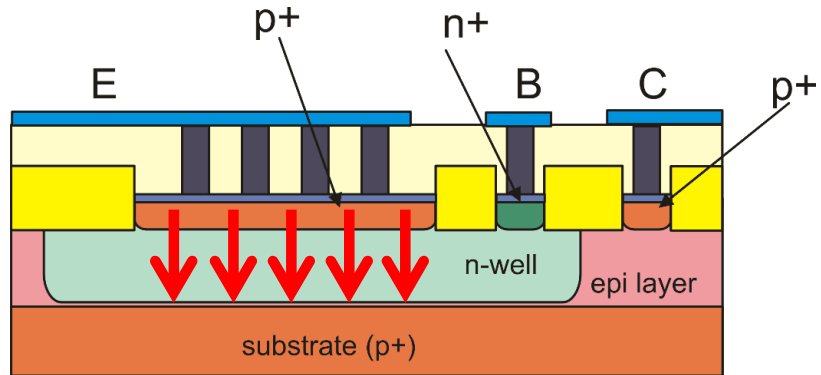


Lower early voltage ( $V_A$ ), due to non-optimal collector doping.

Larger than vertical devices for the same current capability

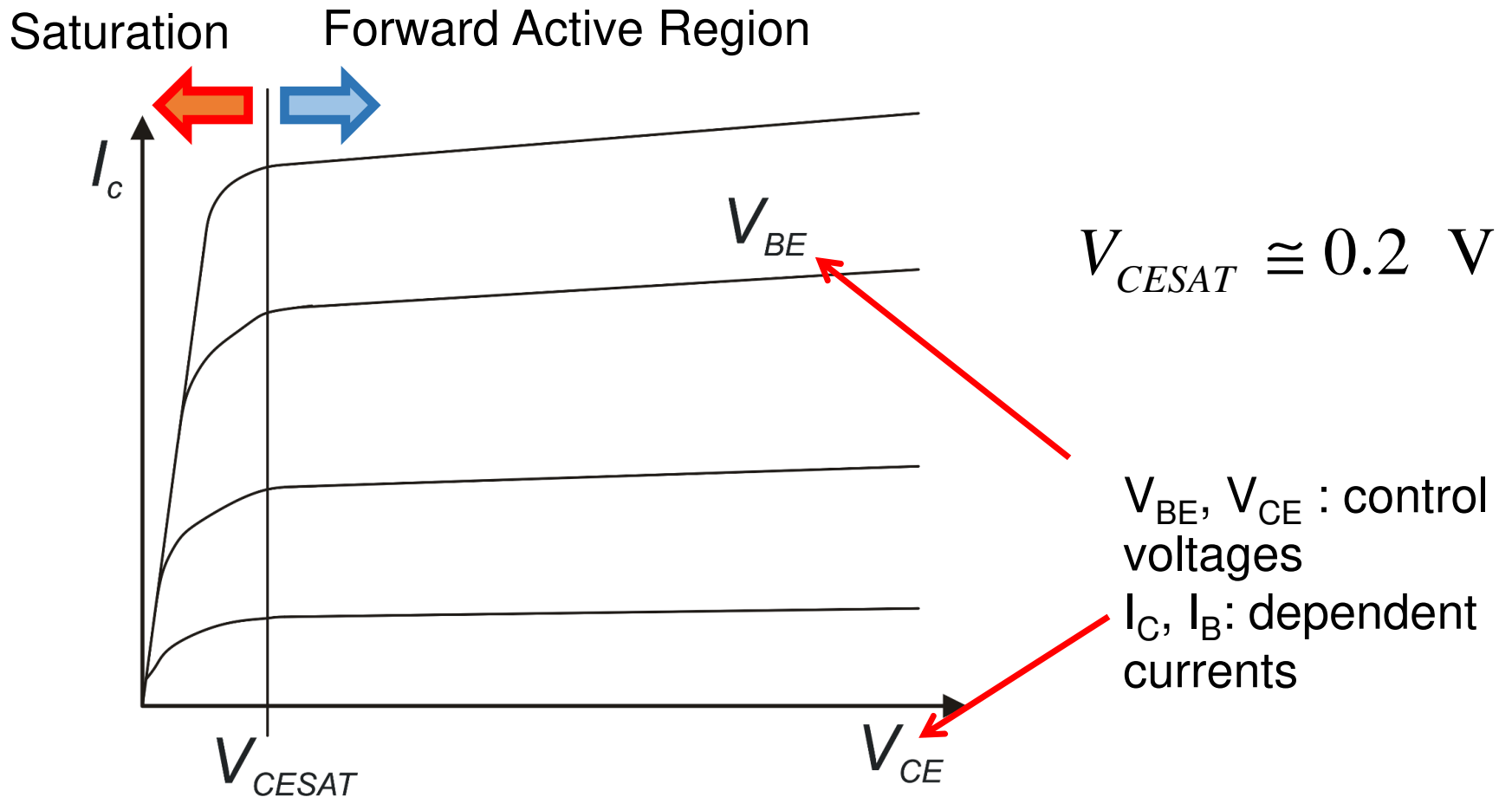


The substrate PNP: compatible with standard CMOS n-well processes



Limitation: The collector is committed to the substrate, (forced to  $V_{SS}$ )

# BJT output characteristics



## BJT model in the forward active zone

$$I_C = I_S e^{\frac{V_{BE}}{V_T}} \left( 1 + \frac{V_{CB}}{V_A} \right) \quad V_{CB} = V_{CE} - V_{BE}$$

$$I_B = \frac{I_C}{\beta_F}$$

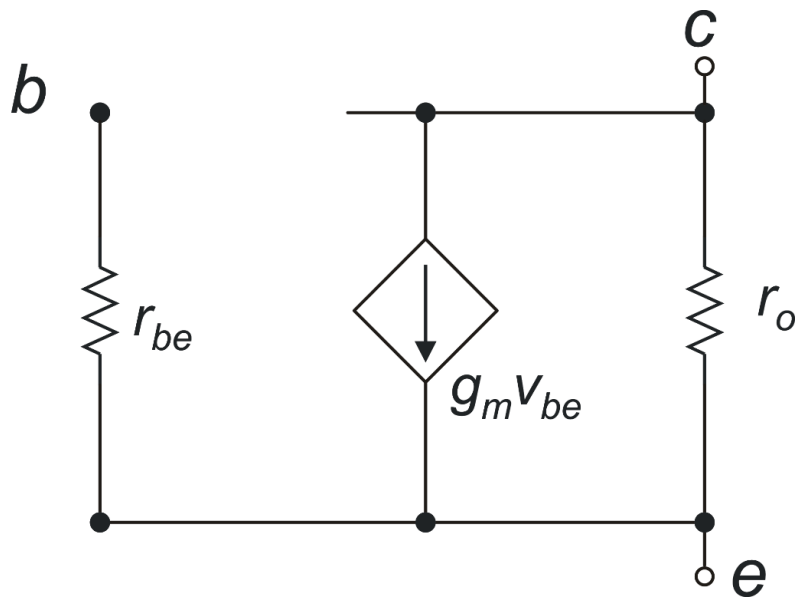
Sometimes this expression is used in order to refer to  $V_{BE}$  and  $V_{CE}$  as control voltages:

$$I_C \cong I_S e^{\frac{V_{BE}}{V_T}} \left( 1 + \frac{V_{CE}}{V_A} \right)$$

For calculation of  $I_C$  and  $I_B$  in all operating zones (saturation, cut-off, forward active, reverse active) the Ebers-Moll model should be used.

# BJT: small signal model

Small signal dc model



$$g_m = \frac{I_C}{V_T} \quad r_o \cong \frac{V_A}{I_C}$$

$$r_{be} = \beta_F \frac{1}{g_m}$$

Equivalence with the MOSFET parameters

$$g_m = \frac{I_D}{V_{TE}} \quad r_d = \frac{1}{g_d} = \frac{1}{\lambda I_D} = \frac{\lambda^{-1}}{I_D}$$

BJT

MOSFET

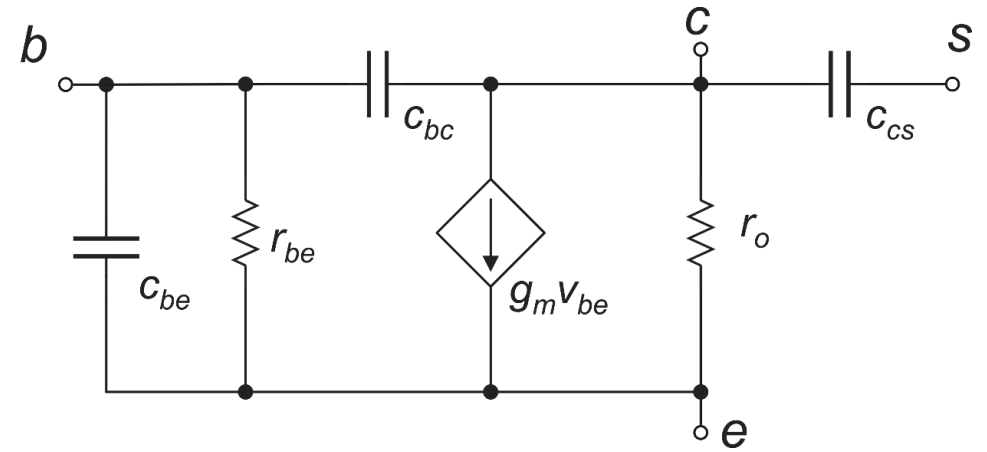
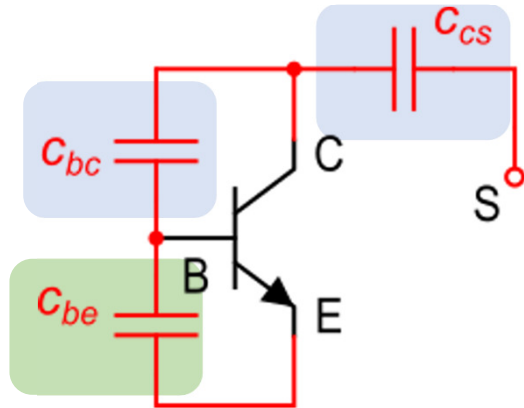
$$V_T \longleftrightarrow V_{TE}$$

$$V_A \longleftrightarrow \lambda^{-1}$$

# BJT capacitances in forward active region (vertical npn)

$$C_{bc} = \frac{C_{JC}}{\left(1 + \frac{V_{CB}}{V_{JC}}\right)^{m_{jc}}}$$

$$C_{cs} = \frac{C_{JS}}{\left(1 + \frac{V_{CS}}{V_{JS}}\right)^{m_{js}}}$$

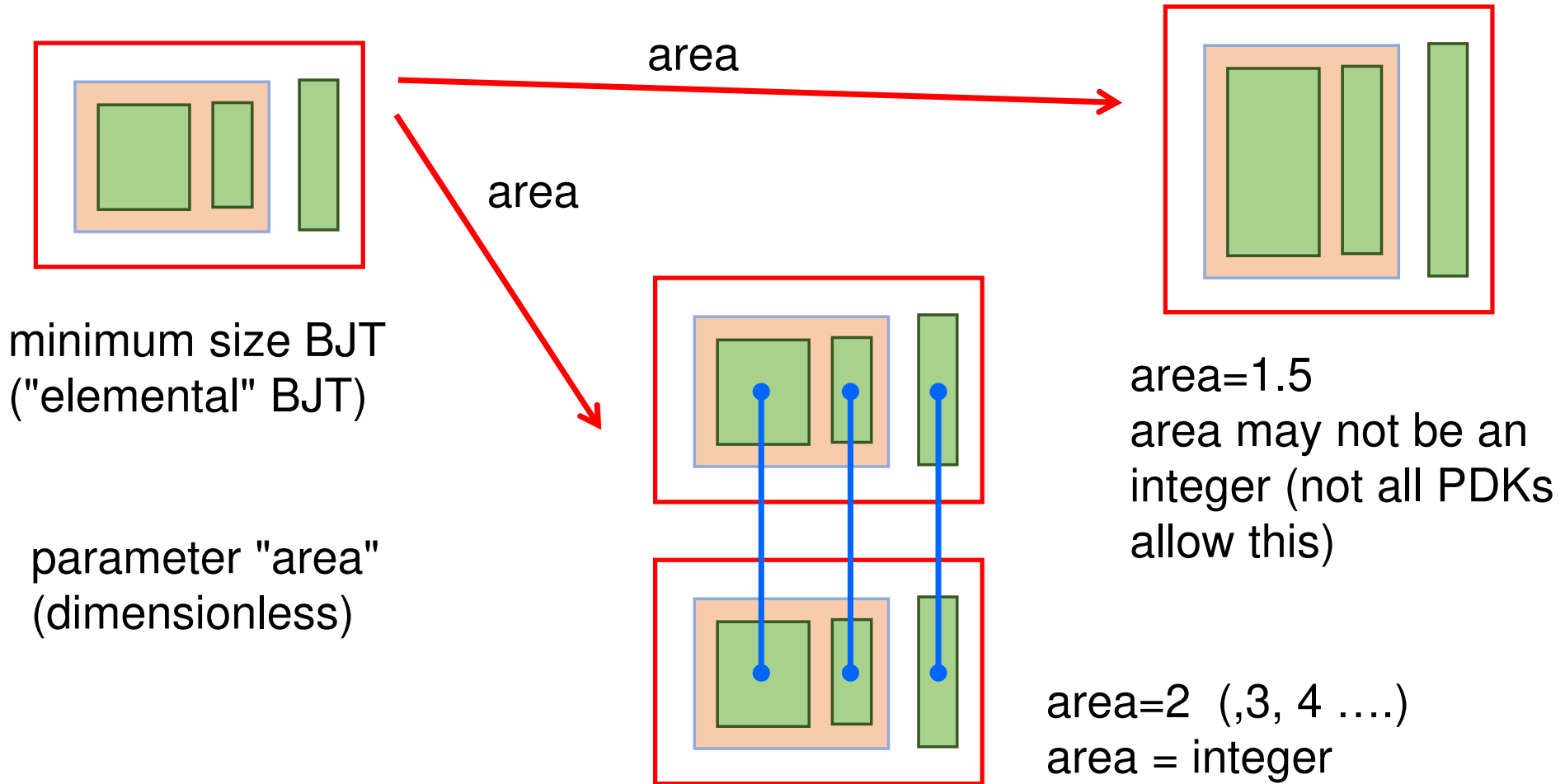


$$C_{be} = \frac{C_{JE}}{\left(1 - \frac{V_{BE}}{V_{JE}}\right)^{m_{je}}} + C_{de} \longrightarrow C_{de} = \tau_F g_m$$

Transition frequency

$$f_T \cong \frac{1}{2\pi\tau_F}$$

# BJTs in Integrated Circuit: instance parameters

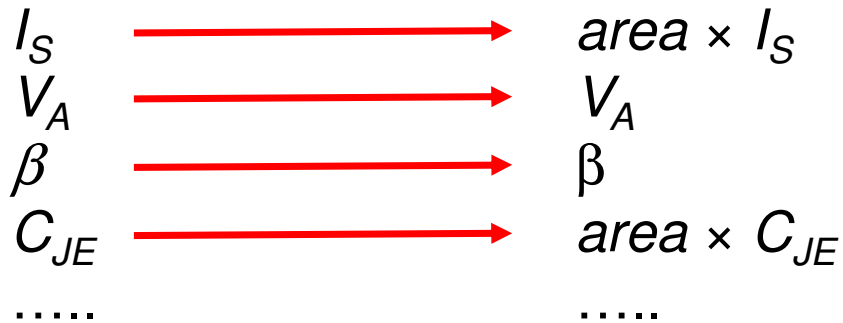


# BJT sizing: Effect of the area parameter on the electrical parameters

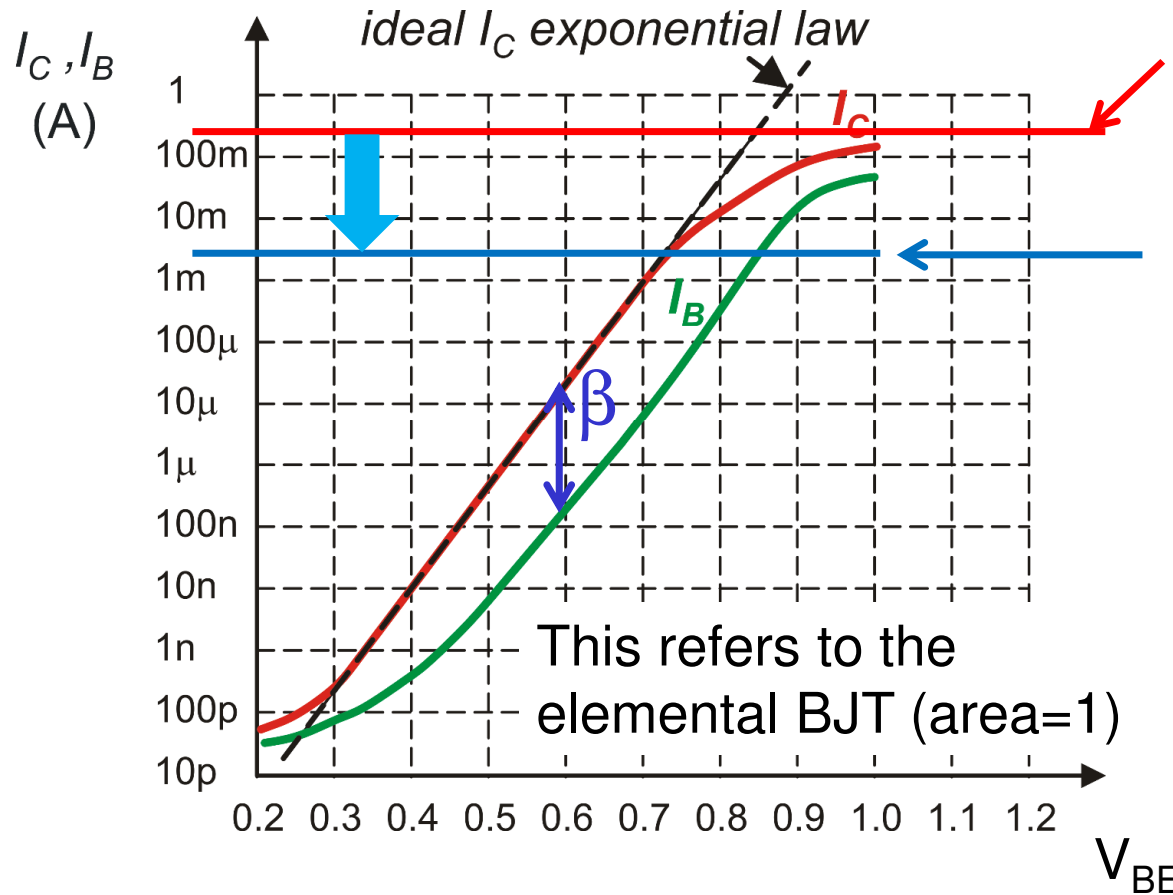
Electrical effects of area parameter:

elemental BJT

elemental BJT with area  
specified as an instance parameter



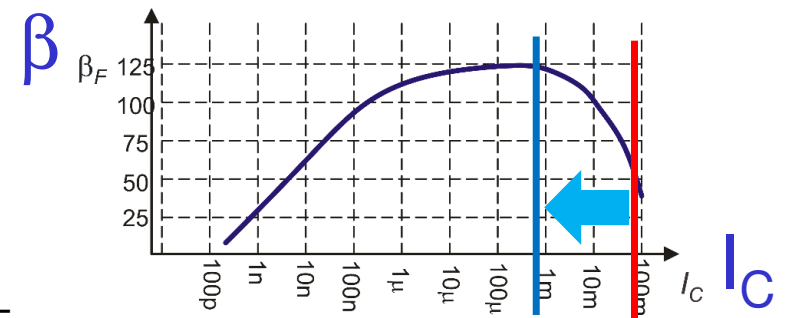
# BJT sizing: Gummel plot and beta plot



Gummel Plot

My BJT has to carry this current (200 mA). The elemental BJT would be damaged

Using a BJT with area=100 would be equivalent to make the elemental BJT work with a current 100 times smaller. This corresponds to the operating point given by the blue line



Beta Plot